

EPROM-Based 8-Bit CMOS Microcontrollers

Devices included in this data sheet:

Referred to collectively as PIC16C55X.

- PIC16C554
- PIC16C558

High Performance RISC CPU:

- · Only 35 instructions to learn
- All single-cycle instructions (200 ns), except for program branches which are two-cycle
- Operating speed:
 - DC 20 MHz clock input
 - DC 200 ns instruction cycle

Device	Program Memory	Data Memory		
PIC16C554	512	80		
PIC16C558	2K	128		

- · Interrupt capability
- 16 special function hardware registers
- 8-level deep hardware stack
- · Direct, Indirect and Relative addressing modes

Peripheral Features:

- 13 I/O pins with individual direction control
- High current sink/source for direct LED drive
- Timer0: 8-bit timer/counter with 8-bit programmable prescaler

Special Microcontroller Features:

- Power-on Reset (POR)
- Power-up Timer (PWRT) and Oscillator Start-up Timer (OST)
- Watchdog Timer (WDT) with its own on-chip RC oscillator for reliable operation

Pin Diagram

PDIP, SOIC, Windowed CERDIP



Special Microcontroller Features (cont'd)

- Programmable code protection
- Power saving SLEEP mode
- Selectable oscillator options
- Serial in-circuit programming (via two pins)
- Four user programmable ID locations

CMOS Technology:

- Low-power, high-speed CMOS EPROM technology
- · Fully static design
- Wide operating voltage range
 2.5V to 5.5V
- Commercial, industrial and extended temperature range
- Low power consumption
 - < 2.0 mA @ 5.0V, 4.0 MHz
 - 15 μA typical @ 3.0V, 32 kHz
 - < 1.0 μA typical standby current @ 3.0V

Device Differences

Device	Voltage Range	Oscillator	Process Technology (Microns)		
PIC16C554	2.5 - 5.5	See Note 1	0.9		
PIC16C558	2.5 - 5.5	See Note 1	0.9		

Note 1: If you change from this device to another device, please verify oscillator characteristics in your application.

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An errata sheet may exist for current devices, describing minor operational differences (from the data sheet) and recommended workarounds. As device/documentation issues become known to us, we will publish an errata sheet. The errata will specify the revision of silicon and revision of document to which it applies.

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Corrections to this Data Sheet

We constantly strive to improve the quality of all our products and documentation. We have spent a great deal of time to ensure that this document is correct. However, we realize that we may have missed a few things. If you find any information that is missing or appears in error, please:

- Fill out and mail in the reader response form in the back of this data sheet.
- E-mail us at webmaster@microchip.com.

We appreciate your assistance in making this a better document.

NOTES:

1.0 GENERAL DESCRIPTION

The PIC16C55X are 18 and 20-Pin EPROM-based members of the versatile PIC16CXX family of low-cost, high-performance, CMOS, fully-static, 8-bit microcontrollers.

All PICmicro[®] microcontrollers employ an advanced RISC architecture. The PIC16C55X have enhanced core features, eight-level deep stack, and multiple internal and external interrupt sources. The separate instruction and data buses of the Harvard architecture allow a 14-bit wide instruction word with the separate 8-bit wide data. The two-stage instruction pipeline allows all instructions to execute in a single-cycle, except for program branches (which require two cycles). A total of 35 instructions (reduced instruction set) are available. Additionally, a large register set gives some of the architectural innovations used to achieve a very high performance.

PIC16C55X microcontrollers typically achieve a 2:1 code compression and a 4:1 speed improvement over other 8-bit microcontrollers in their class.

The PIC16C554 has 80 bytes of RAM. The PIC16C558 has 128 bytes of RAM. Each device has 13 I/O pins and an 8-bit timer/counter with an 8-bit programmable prescaler.

PIC16C55X devices have special features to reduce external components, thus reducing cost, enhancing system reliability and reducing power consumption. There are four oscillator options, of which the single pin RC oscillator provides a low-cost solution, the LP oscillator minimizes power consumption, XT is a standard crystal, and the HS is for High Speed crystals. The SLEEP (power-down) mode offers power saving. The user can wake up the chip from SLEEP through several external and internal interrupts and reset. A highly reliable Watchdog Timer with its own on-chip RC oscillator provides protection against software lock-up.

A UV-erasable CERDIP-packaged version is ideal for code development while the cost-effective One-Time Programmable (OTP) version is suitable for production in any volume.

Table 1-1 shows the features of the PIC16C55X mid-range microcontroller families.

A simplified block diagram of the PIC16C55X is shown in Figure 3-1.

The PIC16C55X series fit perfectly in applications ranging from motor control to low-power remote sensors. The EPROM technology makes customization of application programs (detection levels, pulse generation, timers, etc.) extremely fast and convenient. The small footprint packages make this microcontroller series perfect for all applications with space limitations. Low-cost, low-power, high-performance, ease of use and I/O flexibility make the PIC16C55X very versatile.

1.1 Family and Upward Compatibility

Those users familiar with the PIC16C5X family of microcontrollers will realize that this is an enhanced version of the PIC16C5X architecture. Please refer to Appendix A for a detailed list of enhancements. Code written for PIC16C5X can be easily ported to PIC16C55X family of devices (Appendix B).

The PIC16C55X family fills the niche for users wanting to migrate up from the PIC16C5X family and not needing various peripheral features of other members of the PIC16XX mid-range microcontroller family.

1.2 <u>Development Support</u>

The PIC16C55X family is supported by a full-featured macro assembler, a software simulator, an in-circuit emulator, a low-cost development programmer and a full-featured programmer. A "C" compiler and fuzzy logic support tools are also available.

TABLE 1-1: PIC16C55X FAMILY OF DEVICES

		PIC16C554	PIC16C558
Clock	Maximum Frequency of Operation (MHz)	20	20
	EPROM Program Memory (x14 words)	512	2K
lemory	Data Memory (bytes)	80	128
Peripherals	Timer Module(s)	TMR0	TMR0
	Interrupt Sources	3	3
	I/O Pins	13	13
	Voltage Range (Volts)	2.5-5.5	2.5-5.5
eatures	Brown-out Reset	—	—
	Packages	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP

All PICmicro[®] Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability. All PIC16C55X Family devices use serial programming with clock pin RB6 and data pin RB7.

2.0 PIC16C55X DEVICE VARIETIES

A variety of frequency ranges and packaging options are available. Depending on application and production requirements the proper device option can be selected using the information in the PIC16C55X Product Identification System section at the end of this data sheet. When placing orders, please use this page of the data sheet to specify the correct part number.

2.1 UV Erasable Devices

The UV erasable version, offered in CERDIP package is optimal for prototype development and pilot programs. This version can be erased and reprogrammed to any of the oscillator modes.

Microchip's PICSTART[®] and PROMATE[®] programmers both support programming of the PIC16C55X.

2.2 <u>One-Time-Programmable (OTP)</u> <u>Devices</u>

The availability of OTP devices is especially useful for customers who need the flexibility for frequent code updates and small volume applications. In addition to the program memory, the configuration bits must also be programmed.

2.3 <u>Quick-Turnaround-Production (QTP)</u> <u>Devices</u>

Microchip offers a QTP Programming Service for factory production orders. This service is made available for users who choose not to program a medium to high quantity of units and whose code patterns have stabilized. The devices are identical to the OTP devices but with all EPROM locations and configuration options already programmed by the factory. Certain code and prototype verification procedures apply before production shipments are available. Please contact your Microchip Technology sales office for more details.

2.4 <u>Serialized</u> <u>Quick-Turnaround-Production</u> <u>(SQTPSM) Devices</u>

Microchip offers a unique programming service where a few user-defined locations in each device are programmed with different serial numbers. The serial numbers may be random, pseudo-random or sequential.

Serial programming allows each device to have a unique number which can serve as an entry-code, password or ID number.

NOTES:

3.0 ARCHITECTURAL OVERVIEW

The high performance of the PIC16C55X family can be attributed to a number of architectural features commonly found in RISC microprocessors. To begin with, the PIC16C55X uses a Harvard architecture, in which, program and data are accessed from separate memories using separate busses. This improves bandwidth over traditional von Neumann architecture where program and data are fetched from the same memory. Separating program and data memory further allows instructions to be sized differently than 8-bit wide data words. Instruction opcodes are 14-bits wide making it possible to have all single word instructions. A 14-bit wide program memory access bus fetches a 14-bit instruction in a single cycle. A two-stage pipeline overlaps fetch and execution of instructions. Consequently, all instructions (35) execute in a single-cycle (200 ns @ 20 MHz) except for program branches. The table below lists the memory (EEPROM and ROM).

Device	Program Memory	Data Memory
PIC16C554	512	80
PIC16C558	2K	128

The PIC16C554 addresses 512 x 14 on-chip program memory. The PIC16C558 addresses 2K x 14 program memory. All program memory is internal.

The PIC16C55X can directly or indirectly address its register files or data memory. All special function registers including the program counter are mapped into the data memory. The PIC16C55X have an orthogonal (symmetrical) instruction set that makes it possible to carry out any operation on any register using any addressing mode. This symmetrical nature and lack of 'special optimal situations' make programming with the PIC16C55X simple yet efficient. In addition, the learning curve is reduced significantly.

The PIC16C55X devices contain an 8-bit ALU and working register. The ALU is a general purpose arithmetic unit. It performs arithmetic and Boolean functions between data in the working register and any register file.

The ALU is 8-bits wide and capable of addition, subtraction, shift and logical operations. Unless otherwise mentioned, arithmetic operations are two's complement in nature. In two-operand instructions, typically one operand is the working register (W register). The other operand is a file register or an immediate constant. In single operand instructions, the operand is either the W register or a file register.

The W register is an 8-bit working register used for ALU operations. It is not an addressable register.

Depending on the instruction executed, the ALU may affect the values of the Carry (C), Digit Carry (DC), and Zero (Z) bits in the STATUS register. The C and DC bits operate as a Borrow and Digit Borrow out bit, respectively, in subtraction. See the SUBLW and SUBWF instructions for examples.

A simplified block diagram is shown in Figure 3-1, with a description of the device pins in Table 3-1.

FIGURE 3-1: BLOCK DIAGRAM



Name	DIP SOIC Pin #	SSOP Pin #	I/O/P Type	Buffer Type	Description
OSC1/CLKIN	16	18	I	ST/CMOS	Oscillator crystal input/external clock source input.
OSC2/CLKOUT	15	17	0	_	Oscillator crystal output. Connects to crystal or resonator in crystal oscillator mode. In RC mode, OSC2 pin outputs CLKOUT which has 1/4 the frequency of OSC1, and denotes the instruction cycle rate.
MCLR/Vpp	4	4	I/P	ST	Master clear (reset) input/programming voltage input. This pin is an active low reset to the device.
RAO	17	19	I/O	ST	Bi-directional I/O port
RA1	18	20	I/O	ST	Bi-directional I/O port
RA2	1	1	I/O	ST	Bi-directional I/O port
RA3	2	2	I/O	ST	Bi-directional I/O port
RA4/T0CKI	3	3	I/O	ST	Bi-directional I/O port or external clock input for TMR0. Output is open drain type.
RB0/INT	6	7	I/O	TTL/ST(1)	Bi-directional I/O port can be software programmed for internal weak pull-up. RB0/INT can also be selected as an external interrupt pin.
RB1	7	8	I/O	TTL	Bi-directional I/O port can be software programmed for internal weak pull-up.
RB2	8	9	I/O	TTL	Bi-directional I/O port can be software programmed for internal weak pull-up.
RB3	9	10	I/O	TTL	Bi-directional I/O port can be software programmed for internal weak pull-up.
RB4	10	11	I/O	TTL	Bi-directional I/O port can be software programmed for internal weak pull-up. Interrupt on change pin.
RB5	11	12	I/O	TTL	Bi-directional I/O port can be software programmed for internal weak pull-up. Interrupt on change pin.
RB6	12	13	I/O	TTL/ST ⁽²⁾	Bi-directional I/O port can be software programmed for internal weak pull-up. Interrupt on change pin. Serial pro- gramming clock.
RB7	13	14	I/O	TTL/ST (2)	Bi-directional I/O port can be software programmed for internal weak pull-up. Interrupt on change pin. Serial pro- gramming data.
Vss	5	5,6	Р	—	Ground reference for logic and I/O pins.
Vdd	14	15,16	Р	—	Positive supply for logic and I/O pins.
Legend:	— = TTL =	output Not used = TTL inpu	l ut	/O = input/o = Input	utput P = power ST = Schmitt Trigger input

TABLE 3-1:	PIC16C55X PINOUT DESCRIPTION

Note 1: This buffer is a Schmitt Trigger input when configured as the external interrupt.

Note 2: This buffer is a Schmitt Trigger input when used in serial programming mode.

3.1 Clocking Scheme/Instruction Cycle

The clock input (OSC1/CLKIN pin) is internally divided by four to generate four non-overlapping quadrature clocks namely Q1, Q2, Q3 and Q4. Internally, the program counter (PC) is incremented every Q1, the instruction is fetched from the program memory and latched into the instruction register in Q4. The instruction is decoded and executed during the following Q1 through Q4. The clocks and instruction execution flow are shown in Figure 3-2.

3.2 Instruction Flow/Pipelining

An "Instruction Cycle" consists of four Q cycles (Q1, Q2, Q3 and Q4). The instruction fetch and execute are pipelined such that fetch takes one instruction cycle while decode and execute takes another instruction cycle. However, due to the pipelining, each instruction effectively executes in one cycle. If an instruction causes the program counter to change (e.g., GOTO) then two cycles are required to complete the instruction (Example 3-1).

A fetch cycle begins with the program counter (PC) incrementing in Q1.

In the execution cycle, the fetched instruction is latched into the "Instruction Register (IR)" in cycle Q1. This instruction is then decoded and executed during the Q2, Q3, and Q4 cycles. Data memory is read during Q2 (operand read) and written during Q4 (destination write).



FIGURE 3-2: CLOCK/INSTRUCTION CYCLE

EXAMPLE 3-1: INSTRUCTION PIPELINE FLOW



instruction is "flushed" from the pipeline while the new instruction is being fetched and then executed.

4.0 MEMORY ORGANIZATION

4.1 <u>Program Memory Organization</u>

The PIC16C55X has a 13-bit program counter capable of addressing an 8K x 14 program memory space. Only the first 512 x 14 (0000h - 01FFh) for the PIC16C554 and 2K x 14 (0000h - 07FFh) for the PIC16C558 are physically implemented. Accessing a location above these boundaries will cause a wrap-around within the first 512 x 14 space PIC16C554 or 2K x 14 space PIC16C558. The reset vector is at 0000h and the interrupt vector is at 0004h (Figure 4-1, Figure 4-2).





FIGURE 4-2: PROGRAM MEMORY MAP AND STACK FOR THE PIC16C558



4.2 Data Memory Organization

The data memory (Figure 4-3 and Figure 4-4) is partitioned into two Banks which contain the general purpose registers and the special function registers. Bank 0 is selected when the RP0 bit (STATUS <5>) is cleared. Bank 1 is selected when the RP0 bit is set. The Special Function Registers are located in the first 32 locations of each Bank. Register locations 20-6Fh (Bank0) on the PIC16C554 and 20-7Fh (Bank0) and A0-BFh (Bank1) on the PIC16C558 are general purpose registers implemented as static RAM. Some special purpose registers are mapped in Bank 1.

4.2.1 GENERAL PURPOSE REGISTER FILE

The register file is organized as 80×8 in the PIC16C554 and 128×8 in the PIC16C558. Each can be accessed either directly or indirectly through the File Select Register, FSR (Section 4.4).

FIGURE 4-3: DATA MEMORY MAP FOR THE PIC16C554

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File Address	3		File Address			
00h	INDF ⁽¹⁾	INDF ⁽¹⁾	80h			
01h	TMR0	OPTION	81h			
02h	PCL	PCL				
03h	STATUS	STATUS				
04h	FSR	FSR				
05h	PORTA	TRISA	85h			
06h	PORTB	TRISB	86h			
07h			87h			
08h			88h			
09h			89h			
0Ah	PCLATH	PCLATH	8Ah			
0Bh	INTCON	INTCON	8Bh			
0Ch			8Ch			
0Dh			8Dh			
0Eh		PCON	8Eh			
0Fh			8Fh			
10h			90h			
11h			91h			
12h			92h			
13h			93h			
14h			94h			
15h			95h			
16h			96h			
17h			97h			
18h			98h			
19h			99h			
1Ah			9Ah			
1Bh			9Bh			
1Ch			9Ch			
1Dh			9Dh			
1Eh			9Eh			
1Fh			9Fh			
20h			A0h			
	General Purpose					
6 FL	Register					
6Fh						
70h						
]			 			
7Fh	_	_ .	FFh			
	Bank 0	Bank 1				
	Unimplemented data memory locations, read as '0'. Note 1: Not a physical register.					

FIGURE 4-4: DATA MEMORY MAP FOR THE PIC16C558

File Address	8		File Address				
00h	INDF ⁽¹⁾	INDF ⁽¹⁾	80h				
01h	TMR0	OPTION	81h				
02h	PCL	PCL					
03h	STATUS	STATUS					
04h	FSR	FSR	 84h				
05h	PORTA	TRISA	85h				
06h	PORTB	TRISB					
07h			87h				
08h							
09h							
0Ah	PCLATH	PCLATH	8Ah				
0Bh	INTCON	INTCON	8Bh				
0Ch			8Ch				
0Dh			8Dh				
0Eh		PCON	8Eh				
0Fh			8Fh				
10h			90h				
11h			91h				
12h							
13h			93h				
14h							
15h							
16h			96h				
17h							
18h							
19h			99h				
1Ah			9Ah				
1Bh			9Bh				
1Ch			9Ch				
1Dh			9Dh				
1Eh			9Eh				
1Fh			9Fh				
20h			A0h				
	General	General	7.011				
	Purpose Register	Purpose Register					
	rtogiotor	litegiotoi	BFh				
			C0h				
l I							
7Fh			FFh				
1-01	Bank 0	Bank 1					
	plemented data me	mory locations r	'0' ac bec				
	Not a physical regis		eau as U.				
	tot a physical regit						

4.2.2 SPECIAL FUNCTION REGISTERS

The Special Function Registers are registers used by the CPU and peripheral functions for controlling the desired operation of the device (Table 4-1). These registers are static RAM. The special function registers can be classified into two sets (core and peripheral). The special function registers associated with the "core" functions are described in this section. Those related to the operation of the peripheral features are described in the section of that peripheral feature.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR Reset	Value on all other resets ⁽¹⁾
Bank 0											
00h	INDF	Addressin register)	ig this locat	ion uses co	ntents of F	SR to addre	ess data me	emory (not	a physical	xxxx xxxx	XXXX XXXX
01h	TMR0	Timer0 M	odule's Reg	jister						XXXX XXXX	uuuu uuuu
02h	PCL	Program (Counter's (F	PC) Least S	Significant B	yte				0000 0000	0000 0000
03h	STATUS	IRP ⁽²⁾	RP1 ⁽²⁾	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
04h	FSR	Indirect da	ata memory	address p	ointer					xxxx xxxx	uuuu uuuu
05h	PORTA	_	_	_	RA4	RA3	RA2	RA1	RA0	x xxxx	u uuuu
06h	PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	xxxx xxxx	uuuu uuuu
07h	Unimplemented								1	_	_
08h	Unimplemented									_	_
09h	Unimplemented									_	_
0Ah	PCLATH	_	_	_	Write buff	er for upper	r 5 bits of pi	rogram cou	nter	0 0000	0 0000
0Bh	INTCON	GIE	(3)	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
0Ch	Unimplemented								1	_	_
0Dh-1Eh	Unimplemented										_
1Fh	Unimplemented									_	_
Bank 1											
80h	INDF	Addressin register)	ig this locat	ion uses co	intents of F	SR to addre	ess data me	emory (not	a physical	xxxx xxxx	XXXX XXXX
81h	OPTION	RBPU	INTEDG	TOCS	TOSE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
82h	PCL	Program (L Counter's (F	PC) Least S	l Significant B	yte				0000 0000	0000 0000
83h	STATUS	_	_	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
84h	FSR	Indirect da	ata memory	v address p	ointer					xxxx xxxx	uuuu uuuu
85h	TRISA			_	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	1 1111	1 1111
86h	TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	1111 1111	1111 1111
87h	Unimplemented									-	-
88h	Unimplemented									_	_
89h	Unimplemented									-	-
8Ah	PCLATH	— — Write buffer for upper 5 bits of program counter						0 0000	0 0000		
8Bh	INTCON	GIE	(3)	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
8Ch	Unimplemented									-	-
8Dh	Unimplemented									-	-
8Eh	PCON	—	_	—	_	_	-	POR	_	0-	u-
8Fh-9Eh	Unimplemented									-	-
9Fh	Unimplemented									-	-

TABLE 4-1: SPECIAL REGISTERS FOR THE PIC16C55X

Legend: — = Unimplemented locations read as '0', u = unchanged, x = unknown, q = value depends on condition, shaded = unimplemented

Note 1: Other (non power-up) resets include MCLR reset and Watchdog Timer reset during normal operation.

Note 2: IRP & RP1bits are reserved, always maintain these bits clear.

Note 3: Bit 6 of INTCON register is reserved for future use. Always maintain this bit as clear.

4.2.2.1 STATUS REGISTER

The STATUS register, shown in Figure 4-5, contains the arithmetic status of the ALU, the RESET status and the bank select bits for data memory.

The STATUS register can be the destination for any instruction, like any other register. If the STATUS register is the destination for an instruction that affects the Z, DC or C bits, then the write to these three bits is disabled. These bits are set or cleared according to the device logic. Furthermore, the TO and PD bits are not writable. Therefore, the result of an instruction with the STATUS register as the destination may be different than intended.

For example, CLRF STATUS will clear the upper-three bits and set the Z bit. This leaves the status register as 000uuluu (where u = unchanged).

It is recommended, therefore, that only BCF, BSF, SWAPF and MOVWF instructions be used to alter the STA-TUS register because these instructions do not affect any status bits. For other instructions, not affecting any status bits, see the "Instruction Set Summary".

Note 1:	The IRP and RP1 bits (STATUS<7:6>) are not used by the PIC16C55X and should be programmed as '0'. Use of these bits as general purpose R/W bits is NOT recommended, since this may affect upward compatibility with future
Note 2:	products. The C and DC bits operate as a Borrow and Digit Borrow out bit, respectively, in
	subtraction. See the SUBLW and SUBWF

instructions for examples.

FIGURE 4-5: STATUS REGISTER (ADDRESS 03H OR 83H)

Reserved	Reserved	R/W-0	R-1	R-1	R/W-x	R/W-x	R/W-x	
IRP bit7	RP1	RP0	TO	PD	Z	DC	C bit0	R = Readable bit W = Writable bit - n = Value at POR reset
								-x = Unknown at POR reset
	1 = Bank 2 0 = Bank 0	2, 3 (100h), 1 (00h -	- 1FFh) FFh)		ndirect addr 5X, always r		is bit clear.	
bit 6-5:	<pre>bit 6-5: RP1:RP0: Register Bank Select bits (used for direct addressing) 11 = Bank 3 (180h - 1FFh) 10 = Bank 2 (100h - 17Fh) 01 = Bank 1 (80h - FFh) 00 = Bank 0 (00h - 7Fh) Each bank is 128 bytes. The RP1 bit is reserved on the PIC16C55X, always maintain this bit clear.</pre>							
	TO : Time-o 1 = After p 0 = A WDT	ower-up,		struction, c	or SLEEP ins	struction		
	PD : Power 1 = After p 0 = By exe	ower-up o						
	Z : Zero bit 1 = The result of an arithmetic or logic operation is zero 0 = The result of an arithmetic or logic operation is not zero							
	DC : Digit carry/borrow bit (ADDWF, ADDLW, SUBLW, SUBWF instructions)(for borrow the polarity is reversed) 1 = A carry-out from the 4th low order bit of the result occurred 0 = No carry-out from the 4th low order bit of the result							
	1 = A carry 0 = No car Note: For \overline{b}	/-out from ry-out from oorrow the erand. Fo	the most m the mos polarity is	significant t significar s reversed		esult occuri result occu	red irred uted by add	ding the two's complement of the either the high or low order bit of

4.2.2.2 OPTION REGISTER

The OPTION register is a readable and writable register which contains various control bits to configure the TMR0/WDT prescaler, the external RB0/INT interrupt, TMR0 and the weak pull-ups on PORTB.

Note: To achieve a 1:1 prescaler assignment for TMR0, assign the prescaler to the WDT (PSA = 1).

R/W-1 R/W-1 R/W-1 R/W-1 R/W-1 R/W-1 R/W-1 R/W-1 RBPU INTEDG TOCS **T0SE** PSA PS2 PS1 PS0 R = Readable bit W = Writable bit bit7 bit0 - n = Value at POR reset bit 7: **RBPU:** PORTB Pull-up Enable bit 1 = PORTB pull-ups are disabled 0 = PORTB pull-ups are enabled by individual port latch values bit 6: INTEDG: Interrupt Edge Select bit 1 = Interrupt on rising edge of RB0/INT pin 0 = Interrupt on falling edge of RB0/INT pin TOCS: TMR0 Clock Source Select bit bit 5: 1 = Transition on RA4/T0CKI pin 0 = Internal instruction cycle clock (CLKOUT) TOSE: TMR0 Source Edge Select bit bit 4: 1 = Increment on high-to-low transition on RA4/T0CKI pin 0 = Increment on low-to-high transition on RA4/T0CKI pin bit 3: **PSA**: Prescaler Assignment bit 1 = Prescaler is assigned to the WDT 0 = Prescaler is assigned to the Timer0 module bit 2-0: PS2:PS0: Prescaler Rate Select bits TMR0 Rate Bit Value WDT Rate 1:2 000 1:1001 1:4 1:2 1:8 010 1:4 011 1:16 1:8 100 1:32 1:16 1:64 1:32 101 1:64 110 1:128 111 1:256 1:128

FIGURE 4-6: OPTION REGISTER (ADDRESS 81H)

4.2.2.3 INTCON REGISTER

The INTCON register is a readable and writable register which contains the various enable and flag bits for all interrupt sources.

Note: Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>).

FIGURE 4-7: INTCON REGISTER (ADDRESS 0BH OR 8BH)

R/W-0	Reserved	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-x	
GIE		TOIE	INTE	RBIE	TOIF	INTF	RBIF	R = Readable bit
bit7							bit0	W = Writable bit - n = Value at POR reset - x = Unknown at POR reset
bit 7:	GIE: Globa 1 = Enable 0 = Disabl	es all un-r	nasked in					
bit 6:	— = Reser	ved for fu	iture use.	Always ma	aintain this	bit clear.		
bit 5:	TOIE : TMR 1 = Enable 0 = Disabl	es the TM	R0 interru	ıpt	bit			
bit 4:	INTE: RB0 1 = Enable 0 = Disabl	es the RB	0/INT exte	ernal interr	upt			
bit 3:	RBIE : RB 1 = Enable 0 = Disabl	es the RB	port char	nge interru	pt			
bit 2:	TOIF : TMR 1 = TMR0 0 = TMR0	register h	has overflo	wed (mus	t be cleare	d in softwa	are)	
bit 1:	INTF : RB0 1 = The R 0 = The R	B0/INT e>	ternal inte	errupt occu	urred (mus	t be cleare	d in softwar	e)
bit 0:	RBIF : RB 1 = When 0 = None	at least o	ne of the	RB7:RB4	oins chang		nust be clea	ared in software)

4.2.2.4 PCON REGISTER

The PCON register contains flag bits to differentiate between a Power-on Reset, an external $\overline{\text{MCLR}}$ reset or WDT reset. See Section 7.3 and Section 7.4 for detailed reset operation.

FIGURE 4-8: PCON REGISTER (ADDRESS 8Eh)



4.3 PCL and PCLATH

The program counter (PC) is 13-bits wide. The low byte comes from the PCL register, which is a readable and writable register. The high bits (PC<12:8>) are not directly readable or writable and come from PCLATH. On any reset, the PC is cleared. Figure 4-9 shows the two situations for the loading of the PC. The upper example in the figure shows how the PC is loaded on a write to PCL (PCLATH<4:0> \rightarrow PCH). The lower example in Figure 4-9 shows how the PC is loaded during a CALL or GOTO instruction (PCLATH<4:3> \rightarrow PCH).

FIGURE 4-9: LOADING OF PC IN DIFFERENT SITUATIONS



4.3.1 COMPUTED GOTO

A computed GOTO is accomplished by adding an offset to the program counter (ADDWF PCL). When doing a table read using a computed GOTO method, care should be exercised if the table location crosses a PCL memory boundary (each 256 byte block). Refer to the application note *"Implementing a Table Read"* (AN556).

4.3.2 STACK

The PIC16C55X family has an 8 level deep x 13-bit wide hardware stack (Figure 4-1 and Figure 4-2). The stack space is not part of either program or data space and the stack pointer is not readable or writable. The PC is PUSHed onto the stack when a CALL instruction is executed or an interrupt causes a branch. The stack is POPed in the event of a RETURN, RETLW or a RETFIE instruction execution. PCLATH is not affected by a PUSH or POP operation.

The stack operates as a circular buffer. This means that after the stack has been PUSHed eight times, the ninth push overwrites the value that was stored from the first push. The tenth push overwrites the second push (and so on).

- Note 1: There are no STATUS bits to indicate stack overflow or stack underflow conditions.
- Note 2: There are no instructions mnemonics called PUSH or POP. These are actions that occur from the execution of the CALL, RETURN, RETLW and RETFIE instructions, or vectoring to an interrupt address.

4.4 Indirect Addressing, INDF and FSR Registers

The INDF register is not a physical register. Addressing the INDF register will cause indirect addressing.

Indirect addressing is possible by using the INDF register. Any instruction using the INDF register actually accesses data pointed to by the file select register (FSR). Reading INDF itself indirectly will produce 00h. Writing to the INDF register indirectly results in a no-operation (although status bits may be affected). An effective 9-bit address is obtained by concatenating the 8-bit FSR register and the IRP bit (STATUS<7>), as shown in Figure 4-10. However, IRP is not used in the PIC16C55X. A simple program to clear RAM locations 20h-2Fh using indirect addressing is shown in Example 4-1.

EXAMPLE 4-1: INDIRECT ADDRESSING

NEXT	movlw movwf clrf incf btfss goto	FSR INDF FSR	<pre>;initialize pointer ;to RAM ;clear INDF register ;inc pointer ;all done? ;no clear next</pre>
CONTINUE:			;yes continue

FIGURE 4-10: DIRECT/INDIRECT ADDRESSING PIC16C55X



NOTES:

5.0 I/O PORTS

The PIC16C55X have two ports, PORTA and PORTB.

5.1 PORTA and TRISA Registers

PORTA is a 5-bit wide latch. RA4 is a Schmitt Trigger input and an open drain output. Port RA4 is multiplexed with the TOCKI clock input. All other RA port pins have Schmitt Trigger input levels and full CMOS output drivers. All pins have data direction bits (TRIS registers) which can configure these pins as input or output.

A '1' in the TRISA register puts the corresponding output driver in a hi- impedance mode. A '0' in the TRISA register puts the contents of the output latch on the selected pin(s).

Reading the PORTA register reads the status of the pins, whereas writing to it will write to the port latch. All write operations are read-modify-write operations. So a write to a port implies that the port pins are first read, then this value is modified and written to the port data latch.

Note: On reset, the TRISA register is set to all inputs.

FIGURE 5-1: BLOCK DIAGRAM OF PORT PINS RA<3:0>



FIGURE 5-2: BLOCK DIAGRAM OF RA4 PIN



TABLE 5-1: PORTA FUNCTIONS

Name	Bit #	Buffer Type	Function
RA0	bit0	ST	Bi-directional I/O port.
RA1	bit1	ST	Bi-directional I/O port.
RA2	bit2	ST	Bi-directional I/O port.
RA3	bit3	ST	Bi-directional I/O port.
RA4/T0CKI	bit4	ST	Bi-directional I/O port or external clock input for TMR0. Output is open drain type.

Legend: ST = Schmitt Trigger input

TABLE 5-2: SUMMARY OF REGISTERS ASSOCIATED WITH PORTA

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR	Value on All Other Resets
05h	PORTA	—	—	—	RA4	RA3	RA2	RA1	RA0	x xxxx	u uuuu
85h	TRISA	—	—	—	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	1 1111	1 1111

Legend: — = Unimplemented locations, read as '0'

x = unknown

u = unchanged

Note: Shaded bits are not used by PORTA.

5.2 PORTB and TRISB Registers

PORTB is an 8-bit wide bi-directional port. The corresponding data direction register is TRISB. A '1' in the TRISB register puts the corresponding output driver in a high impedance mode. A '0' in the TRISB register puts the contents of the output latch on the selected pin(s).

Reading PORTB register reads the status of the pins, whereas writing to it will write to the port latch. All write operations are read-modify-write operations. So a write to a port implies that the port pins are first read, then this value is modified and written to the port data latch.

Each of the PORTB pins has a weak internal pull-up ($\approx 200 \,\mu$ A typical). A single control bit can turn on all the pull-ups. This is done by clearing the RBPU (OPTION<7>) bit. The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on Power-on Reset.

Four of PORTB's pins, RB7:RB4, have an interrupt on change feature. Only pins configured as inputs can cause this interrupt to occur (i.e., any RB7:RB4 pin configured as an output is excluded from the interrupt on change comparison). The input pins (of RB7:RB4) are compared with the old value latched on the last read of PORTB. The "mismatch" outputs of RB7:RB4 are OR'ed together to generate the RBIF interrupt (flag latched in INTCON<0>). This interrupt can wake the device from SLEEP. The user, in the interrupt service routine, can clear the interrupt in the following manner:

- a) Any read or write of PORTB. This will end the mismatch condition.
- b) Clear flag bit RBIF.

A mismatch condition will continue to set flag bit RBIF. Reading PORTB will end the mismatch condition, and allow flag bit RBIF to be cleared.

This interrupt on mismatch feature, together with software configurable pull-ups on these four pins allow easy interface to a key pad and make it possible for wake-up on key-depression. (See AN552 in the Microchip *Embedded Control Handbook*.)

Note: If a change on the I/O pin should occur when the read operation is being executed (start of the Q2 cycle), then the RBIF interrupt flag may not get set.

The interrupt on change feature is recommended for wake-up on key depression operation and operations where PORTB is only used for the interrupt on change feature. Polling of PORTB is not recommended while using the interrupt on change feature.

FIGURE 5-3: BLOCK DIAGRAM OF RB7:RB4 PINS



FIGURE 5-4: BLOCK DIAGRAM OF RB3:RB0 PINS



TABLE 5-3: PORTB FUNCTIONS

Name	Bit #	Buffer Type	Function
RB0/INT	bit0	TTL/ST ⁽¹⁾	Input/output or external interrupt input. Internal software programmable weak pull-up.
RB1	bit1	TTL	Input/output pin. Internal software programmable weak pull-up.
RB2	bit2	TTL	Input/output pin. Internal software programmable weak pull-up.
RB3	bit3	TTL	Input/output pin. Internal software programmable weak pull-up.
RB4	bit4	TTL	Input/output pin (with interrupt on change). Internal software programmable weak pull-up.
RB5	bit5	TTL	Input/output pin (with interrupt on change). Internal software programmable weak pull-up.
RB6	bit6	TTL/ST ⁽²⁾	Input/output pin (with interrupt on change). Internal software programmable weak pull-up. Serial programming clock pin.
RB7	bit7	TTL/ST ⁽²⁾	Input/output pin (with interrupt on change). Internal software programmable weak pull-up. Serial programming data pin.

Legend: ST = Schmitt Trigger, TTL = TTL input

Note 1: This buffer is a Schmitt Trigger input when configured as the external interrupt.

Note 2: This buffer is a Schmitt Trigger input when used in serial programming mode.

TABLE 5-4:SUMMARY OF REGISTERS ASSOCIATED WITH PORTB

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR	Value on All Other Rests
06h	PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	xxxx xxxx	uuuu uuuu
86h	TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	1111 1111	1111 1111
81h	OPTION	RBPU	INTEDG	TOCS	TOSE	PSA	PS2	PS1	PS0	1111 1111	1111 1111

Legend: x = unknown, u = unchanged

Note: Shaded bits are not used by PORTB.

5.3 I/O Programming Considerations

5.3.1 BI-DIRECTIONAL I/O PORTS

Any instruction which writes, operates internally as a read followed by a write operation. The BCF and BSF instructions, for example, read the register into the CPU, execute the bit operation and write the result back to the register. Caution must be used when these instructions are applied to a port with both inputs and outputs defined. For example, a BSF operation on bit5 of PORTB will cause all eight bits of PORTB to be read into the CPU. Then the BSF operation takes place on bit5 and PORTB is written to the output latches. If another bit of PORTB is used as a bidirectional I/O pin (e.g., bit0) and it is defined as an input at this time, the input signal present on the pin itself would be read into the CPU and re-written to the data latch of this particular pin, overwriting the previous content. As long as the pin stays in the input mode, no problem occurs. However, if bit0 is switched into output mode later on, the content of the data latch may now be unknown.

Reading the port register, reads the values of the port pins. Writing to the port register writes the value to the port latch. When using read modify write instructions (ex. BCF, BSF, etc.) on a port, the value of the port pins is read, the desired operation is done to this value, and this value is then written to the port latch.

Example 5-1 shows the effect of two sequential read-modify-write instructions (ex., ${\tt BCF}$, ${\tt BSF}$ etc.) on an I/O port

A pin actively outputting a Low or High should not be driven from external devices at the same time in order to change the level on this pin ("wired-or", "wired-and"). The resulting high output currents may damage the chip.

EXAMPLE 5-1: READ-MODIFY-WRITE INSTRUCTIONS ON AN I/O PORT

; Initial PORT settings: PORTB<7:4> Inputs PORTB<3:0> Outputs ; ; PORTB<7:6> have external pull-up and are not ; connected to other circuitry ; PORT latch PORT pins ; BCF PORTB, 7 ; 01pp pppp 11pp pppp BCF PORTB, 6 ; 10pp pppp 11pp pppp BSF STATUS, RPO ; ;10pp pppp BCF TRISB, 7 11pp pppp BCF TRISB, 6 ;10pp pppp 10pp pppp ; ; Note that the user may have expected the pin ; values to be 00pp pppp. The 2nd BCF caused ; RB7 to be latched as the pin value (High).

5.3.2 SUCCESSIVE OPERATIONS ON I/O PORTS

The actual write to an I/O port happens at the end of an instruction cycle, whereas for reading, the data must be valid at the beginning of the instruction cycle (Figure 5-5). Therefore, care must be exercised if a write followed by a read operation is carried out on the same I/O port. The sequence of instructions should be such to allow the pin voltage to stabilize (load dependent) before the next instruction which causes that file to be read into the CPU is executed. Otherwise, the previous state of that pin may be read into the CPU rather than the new state. When in doubt, it is better to separate these instructions with an NOP or another instruction not accessing this I/O port.



FIGURE 5-5: SUCCESSIVE I/O OPERATION

NOTES:

6.0 TIMER0 MODULE

The Timer0 module timer/counter has the following features:

- 8-bit timer/counter
- · Readable and writable
- 8-bit software programmable prescaler
- Internal or external clock select
- Interrupt on overflow from FFh to 00h
- Edge select for external clock

Figure 6-1 is a simplified block diagram of the Timer0 module.

Timer mode is selected by clearing the T0CS bit (OPTION<5>). In timer mode, the TMR0 will increment every instruction cycle (without prescaler). If Timer0 is written, the increment is inhibited for the following two cycles (Figure 6-2 and Figure 6-3). The user can work around this by writing an adjusted value to TMR0.

Counter mode is selected by setting the T0CS bit. In this mode Timer0 will increment either on every rising or falling edge of pin RA4/T0CKI. The incrementing edge is determined by the source edge (T0SE) control bit (OPTION<4>). Clearing the T0SE bit selects the rising edge. Restrictions on the external clock input are discussed in detail in Section 6.2.

The prescaler is shared between the Timer0 module and the WatchdogTimer. The prescaler assignment is controlled in software by the control bit PSA (OPTION<3>). Clearing the PSA bit will assign the prescaler to Timer0. The prescaler is not readable or writable. When the prescaler is assigned to the Timer0 module, prescale value of 1:2, 1:4, ..., 1:256 are selectable. Section 6.3 details the operation of the prescaler.

6.1 <u>TIMER0 Interrupt</u>

Timer0 interrupt is generated when the TMR0 register timer/counter overflows from FFh to 00h. This overflow sets the T0IF bit. The interrupt can be masked by clearing the T0IE bit (INTCON<5>). The T0IF bit (INTCON<2>) must be cleared in software by the Timer0 module interrupt service routine before re-enabling this interrupt. The Timer0 interrupt cannot wake the processor from SLEEP since the timer is shut off during SLEEP. See Figure 6-4 for Timer0 interrupt timing.



FIGURE 6-2: TIMER0 (TMR0) TIMING: INTERNAL CLOCK/NO PRESCALER





FIGURE 6-3: TIMER0 TIMING: INTERNAL CLOCK/PRESCALE 1:2

FIGURE 6-4: TIMER0 INTERRUPT TIMING



6.2 Using Timer0 with External Clock

When an external clock input is used for Timer0, it must meet certain requirements. The external clock requirement is due to internal phase clock (Tosc) synchronization. Also, there is a delay in the actual incrementing of Timer0 after synchronization.

6.2.1 EXTERNAL CLOCK SYNCHRONIZATION

When no prescaler is used, the external clock input is the same as the prescaler output. The synchronization of T0CKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks (Figure 6-5). Therefore, it is necessary for T0CKI to be high for at least 2Tosc (and a small RC delay of 20 ns) and low for at least 2Tosc (and a small RC delay of 20 ns). Refer to the electrical specification of the desired device. When a prescaler is used, the external clock input is divided by the asynchronous ripple-counter type prescaler so that the prescaler output is symmetrical. For the external clock to meet the sampling requirement, the ripple-counter must be taken into account. Therefore, it is necessary for TOCKI to have a period of at least 4Tosc (and a small RC delay of 40 ns) divided by the prescaler value. The only requirement on TOCKI high and low time is that they do not violate the minimum pulse width requirement of 10 ns. Refer to parameters 40, 41 and 42 in the electrical specification of the desired device.

6.2.2 TIMER0 INCREMENT DELAY

Since the prescaler output is synchronized with the internal clocks, there is a small delay from the time the external clock edge occurs to the time the TMR0 is actually incremented. Figure 6-5 shows the delay from the external clock edge to the timer incrementing.



FIGURE 6-5: TIMER0 TIMING WITH EXTERNAL CLOCK

6.3 <u>Prescaler</u>

An 8-bit counter is available as a prescaler for the Timer0 module, or as a postscaler for the Watchdog Timer, respectively (Figure 6-6). For simplicity, this counter is being referred to as "prescaler" throughout this data sheet. Note that there is only one prescaler available which is mutually exclusive between the Timer0 module and the Watchdog Timer. Thus, a prescaler assignment for the Timer0 module means that there is no prescaler for the Watchdog Timer, and vice-versa. The PSA and PS2:PS0 bits (OPTION<3:0>) determine the prescaler assignment and prescale ratio.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (e.g., CLRF 1, MOVWF 1, BSF 1, x....etc.) will clear the prescaler. When assigned to WDT, a CLRWDT instruction will clear the prescaler along with the Watchdog Timer. The prescaler is not readable or writable.





6.3.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control (i.e., it can be changed "on the fly" during program execution). To avoid an unintended device RESET, the following instruction sequence (Example 6-1) must be executed when changing the prescaler assignment from Timer0 to WDT. Lines 5-7 are required only if the desired postscaler rate is 1:1 (PS<2:0> = 000) or 1:2 (PS<2:0> = 001).

EXAMPLE 6-1: CHANGING PRESCALER (TIMER0 \rightarrow WDT)

1.BCF	STATUS, RPO	;Skip if already in ; Bank 0
2.CLRWDT		;Clear WDT
3.CLRF	TMR0	;Clear TMR0 & Prescaler
4.BSF	STATUS, RPO	;Bank 1
5.MOVLW	'00101111'b;	;These 3 lines (5, 6, 7)
6.MOVWF	OPTION	; are required only if
		; desired PS<2:0> are
7.CLRWDT		; 000 or 001
8.MOVLW	'00101xxx'b	;Set Postscaler to
9.MOVWF	OPTION	; desired WDT rate
10.BCF	STATUS, RPO	;Return to Bank 0

To change prescaler from the WDT to the TMR0 module use the sequence shown in Example 6-2. This precaution must be taken even if the WDT is disabled.

EXAMPLE 6-2: CHANGING PRESCALER (WDT -> TIMER0)

CLRWDT		;Clear WDT and ;prescaler
		Prescarer
BSF	STATUS, RPO	
MOVLW	b'xxxx0xxx'	;Select TMR0, new
		;prescale value and
		;clock source
MOVWF	OPTION	
BCF	STATUS, RPO	

TABLE 6-1: REGISTERS ASSOCIATED WITH TIMER0

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	1 Bit 0 Value on POR		Value on All Other Resets
01h	TMR0	Timer0 n	nodule's reg	gister						XXXX XXXX	uuuu uuuu
0Bh/8Bh	INTCON	GIE	+	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000x
81h	OPTION	RBPU	INTEDG	TOCS	TOSE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
85h	TRISA	_	_	_	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	1 1111	1 1111

Legend: — = Unimplemented locations, read as '0'.

+ = Reserved for future use.

Note: Shaded bits are not used by TMR0 module.

NOTES:

7.0 SPECIAL FEATURES OF THE CPU

What sets a microcontroller apart from other processors are special circuits to deal with the needs of real time applications. The PIC16C55X family has a host of such features intended to maximize system reliability, minimize cost through elimination of external components, provide power saving operating modes and offer code protection.

These are:

- 1. OSC selection
- 2. Reset Power-on Reset (POR) Power-up Timer (PWRT) Oscillator Start-Up Timer (OST)
- 3. Interrupts
- 4. Watchdog Timer (WDT)
- 5. SLEEP
- 6. Code protection
- 7. ID Locations
- 8. In-circuit serial programming[™]

The PIC16C55X has a Watchdog Timer which is controlled by configuration bits. It runs off its own RC oscillator for added reliability. There are two timers that offer necessary delays on power-up. One is the Oscillator Start-up Timer (OST), intended to keep the chip in reset until the crystal oscillator is stable. The other is the Power-up Timer (PWRT), which provides a fixed delay of 72 ms (nominal) on power-up only, designed to keep the part in reset while the power supply stabilizes. With these two functions on-chip, most applications need no external reset circuitry.

The SLEEP mode is designed to offer a very low current power-down mode. The user can wake-up from SLEEP through external reset, Watchdog Timer wake-up or through an interrupt. Several oscillator options are also made available to allow the part to fit the application. The RC oscillator option saves system cost while the LP crystal option saves power. A set of configuration bits are used to select various options.

7.1 Configuration Bits

The configuration bits can be programmed (read as '0') or left unprogrammed (read as '1') to select various device configurations. These bits are mapped in program memory location 2007h.

The user will note that address 2007h is beyond the user program memory space. In fact, it belongs to the special test/configuration memory space (2000h - 3FFFh), which can be accessed only during programming.

FIGURE 7-1: CONFIGURATION WORD

CP1 C	P0 ¹ CP1	CP0 ¹	CP1	CP0 ¹	—	Reserved	CP1	CP0 ¹	PWRTE	WDTE	F0SC1	F0SC0		Address
bit13	·											bit0	REGISTER:	2007h
bit 13-8 5-4:	CP<1:0> 11 = Pro 10 = 040 01 = 020 11 = 000	gram Me 10h - 07F 10h - 07F	emory o Fh coo Fh coo	code pro le prote le prote	cted cted	off								
bit 7:	Unimple	mented	: Read	as '1'										
bit 6:	Reserve	d: Do no	ot use											
bit 3:	PWRTE 1 = PWF 0 = PWF	T disabl	ed	er Enabl	ə bit									
bit 2:	WDTE : \ 1 = WDT 0 = WDT	enabled	Ł	Enable	bit									
bit 1-0:	11 = RC 10 = HS 01 = XT	oscillato	or or or	tor Sele	ction bi	ts								
7.2 Oscillator Configurations

7.2.1 OSCILLATOR TYPES

The PIC16C55X can be operated in four different oscillator options. The user can program two configuration bits (FOSC1 and FOSC0) to select one of these four modes:

- LP Low Power Crystal
- XT Crystal/Resonator
- HS High Speed Crystal/Resonator
- RC Resistor/Capacitor

7.2.2 CRYSTAL OSCILLATOR / CERAMIC RESONATORS

In XT, LP or HS modes a crystal or ceramic resonator is connected to the OSC1 and OSC2 pins to establish oscillation (Figure 7-2). The PIC16C55X oscillator design requires the use of a parallel cut crystal. Use of a series cut crystal may give a frequency out of the crystal manufacturers specifications. When in XT, LP or HS modes, the device can have an external clock source to drive the OSC1 pin (Figure 7-3).

FIGURE 7-2: CRYSTAL OPERATION (OR CERAMIC RESONATOR) (HS, XT OR LP OSC CONFIGURATION)



See Table 7-1 and Table 7-2 for recommended values of C1 and C2.

Note: A series resistor may be required for AT strip cut crystals.

FIGURE 7-3: EXTERNAL CLOCK INPUT OPERATION (HS, XT OR LP OSC CONFIGURATION)



TABLE 7-1:CAPACITOR SELECTION
FOR CERAMIC RESONATORS
(PRELIMINARY)

Ranges	Characterized:		
Mode	Freq	OSC2(C2)	
ХТ	455 kHz	22 - 100 pF	22 - 100 pF
	2.0 MHz	15 - 68 pF	15 - 68 pF
	4.0 MHz	15 - 68 pF	15 - 68 pF
HS	8.0 MHz	10 - 68 pF	10 - 68 pF
	16.0 MHz	10 - 22 pF	10 - 22 pF

Higher capacitance increases the stability of the oscillator but also increases the start-up time. These values are for design guidance only. Since each resonator has its own characteristics, the user should consult with the resonator manufacturer for appropriate values of external components.

TABLE 7-2:CAPACITOR SELECTION
FOR CRYSTAL OSCILLATOR
(PRELIMINARY)

Mode	Freq	OSC1(C1)	OSC2(C2)
LP	32 kHz	68 - 100 pF	68 - 100 pF
	200 kHz	15 - 30 pF	15 - 30 pF
хт	100 kHz	68 - 150 pF	150 - 200 pF
	2 MHz	15 - 30 pF	15 - 30 pF
	4 MHz	15 - 30 pF	15 - 30 pF
HS	8 MHz	15 - 30 pF	15 - 30 pF
	10 MHz	15 - 30 pF	15 - 30 pF
	20 MHz	15 - 30 pF	15 - 30 pF

Higher capacitance increases the stability of the oscillator but also increases the start-up time. These values are for design guidance only. Rs may be required in HS mode as well as XT mode to avoid overdriving crystals with low drive level specification. Since each crystal has its own characteristics, the user should consult with the crystal manufacturer for appropriate values of external components.

7.2.3 EXTERNAL CRYSTAL OSCILLATOR CIRCUIT

Either a pre-packaged oscillator can be used or a simple oscillator circuit with TTL gates can be built. Prepackaged oscillators provide a wide operating range and better stability. A well-designed crystal oscillator will provide good performance with TTL gates. Two types of crystal oscillator circuits can be used; one with series resonance, or one with parallel resonance.

Figure 7-4 shows implementation of a parallel resonant oscillator circuit. The circuit is designed to use the fundamental frequency of the crystal. The 74AS04 inverter performs the 180° phase shift that a parallel oscillator requires. The 4.7 k Ω resistor provides the negative feedback for stability. The 10 k Ω potentiometers bias the 74AS04 in the linear region. This could be used for external oscillator designs.

FIGURE 7-4: EXTERNAL PARALLEL RESONANT CRYSTAL OSCILLATOR CIRCUIT



Figure 7-5 shows a series resonant oscillator circuit. This circuit is also designed to use the fundamental frequency of the crystal. The inverter performs a 180° phase shift in a series resonant oscillator circuit. The 330 Ω resistors provide the negative feedback to bias the inverters in their linear region.

FIGURE 7-5: EXTERNAL SERIES RESONANT CRYSTAL OSCILLATOR CIRCUIT



7.2.4 RC OSCILLATOR

For timing insensitive applications the "RC" device option offers additional cost savings. The RC oscillator frequency is a function of the supply voltage, the resistor (Rext) and capacitor (Cext) values, and the operating temperature. In addition to this, the oscillator frequency will vary from unit to unit due to normal process parameter variation. Furthermore, the difference in lead frame capacitance between package types will also affect the oscillation frequency, especially for low Cext values. The user also needs to take into account variation due to tolerance of external R and C components used. Figure 7-6 shows how the R/C combination is connected to the PIC16C55X. For Rext values below 2.2 k Ω , the oscillator operation may become unstable, or stop completely. For very high Rext values (e.g., 1 M Ω), the oscillator becomes sensitive to noise, humidity and leakage. Thus, we recommend to keep Rext between 3 k Ω and 100 k Ω .

Although the oscillator will operate with no external capacitor (Cext = 0 pF), we recommend using values above 20 pF for noise and stability reasons. With no or small external capacitance, the oscillation frequency can vary dramatically due to changes in external capacitances, such as PCB trace capacitance or package lead frame capacitance.

The oscillator frequency, divided by 4, is available on the OSC2/CLKOUT pin, and can be used for test purposes or to synchronize other logic (Figure 3-2 for waveform).



FIGURE 7-6: RC OSCILLATOR MODE

7.3 <u>Reset</u>

The PIC16C55X differentiates between various kinds of reset:

- a) Power-on reset (POR)
- b) MCLR reset during normal operation
- c) MCLR reset during SLEEP
- d) WDT reset (normal operation)
- e) WDT wake-up (SLEEP)

Some registers are not affected in any reset condition; their status is unknown on POR and unchanged in any other reset. Most other registers are reset to a "reset state" on Power-on reset, on MCLR or WDT reset and

on $\overline{\text{MCLR}}$ reset during SLEEP. They are not affected by a WDT wake-up, since this is viewed as the resumption of normal operation. $\overline{\text{TO}}$ and $\overline{\text{PD}}$ bits are set or cleared differently in different reset situations as indicated in Table 7-4. These bits are used in software to determine the nature of the reset. See Table 7-6 for a full description of reset states of all registers.

A simplified block diagram of the on-chip reset circuit is shown in Figure 7-7.

The $\overline{\text{MCLR}}$ reset path has a noise filter to detect and ignore small pulses. See Table 10-4 for pulse width specification.





7.4 <u>Power-on Reset (POR), Power-up</u> <u>Timer (PWRT), Oscillator Start-up</u> <u>Timer (OST)</u>

7.4.1 POWER-ON RESET (POR)

A Power-on Reset pulse is generated on-chip when VDD rise is detected (in the range of 1.6 V - 1.8 V). To take advantage of the POR, just tie the $\overline{\text{MCLR}}$ pin through a resistor to VDD. This will eliminate external RC components usually needed to create Power-on Reset. A maximum rise time for VDD is required. See Electrical Specifications for details.

The POR circuit does not produce internal reset when VDD declines.

When the device starts normal operation (exits the reset condition), device operating parameters (voltage, frequency, temperature, etc.) must be met to ensure operation. If these conditions are not met, the device must be held in reset until the operating conditions are met.

For additional information, refer to Application Note AN607 "Power-up Trouble Shooting".

7.4.2 POWER-UP TIMER (PWRT)

The Power-up Timer provides a fixed 72 ms (nominal) time-out on power-up only, from POR. The Power-up Timer operates on an internal RC oscillator. The chip is kept in reset as long as PWRT is active. The PWRT delay allows the VDD to rise to an acceptable level. A configuration bit, PWRTE can disable (if set) or enable (if cleared or programmed) the Power-up Timer. The Power-Up Time delay will vary from chip to chip and due to VDD, temperature and process variation. See DC parameters for details.

7.4.3 OSCILLATOR START-UP TIMER (OST)

The Oscillator Start-Up Timer (OST) provides a 1024 oscillator cycle (from OSC1 input) delay after the PWRT delay is over. This ensures that the crystal oscillator or resonator has started and stabilized.

The OST time-out is invoked only for XT, LP and HS modes and only on power-on reset or wake-up from SLEEP.

7.4.4 TIME-OUT SEQUENCE

On power-up, the time-out sequence is as follows: First PWRT time-out is invoked after POR has expired, then OST is activated. The total time-out will vary based on oscillator configuration and PWRTE bit status. For example, in RC mode with PWRTE bit erased (PWRT disabled), there will be no time-out at all. Figure 7-8, Figure 7-9 and Figure 7-10 depict time-out sequences.

Since the time-outs occur from the POR pulse, if $\overline{\text{MCLR}}$ is kept low long enough, the time-outs will expire. Then bringing $\overline{\text{MCLR}}$ high will begin execution immediately (see Figure 7-9). This is useful for testing purposes or to synchronize more than one PIC16C55X device operating in parallel.

Table 7-5 shows the reset conditions for some special registers, while Table 7-6 shows the reset conditions for all the registers.

7.4.5 POWER CONTROL/STATUS REGISTER (PCON)

Bit1 is \overrightarrow{POR} (Power-on-reset). It is a '0' on power-on-reset and unaffected otherwise. The user must write a '1' to this bit following a power-on-reset. On a subsequent reset if \overrightarrow{POR} is '0', it will indicate that a power-on-reset must have occurred (VDD may have gone too low).

TABLE 7-3: TIME-OUT IN VARIOUS SITUATIONS

Oscillator Configuration	Powe	Wake-up from		
Oscillator Configuration	PWRTE = 0 PWRTE = 1		SLEEP	
XT, HS, LP	72 ms + 1024 Tosc	1024 Tosc	1024 Tosc	
RC	72 ms	—	—	

TABLE 7-4: STATUS BITS AND THEIR SIGNIFICANCE

POR	TO	PD	
0	1	1	Power-on-reset
0	0	Х	Illegal, TO is set on POR
0	Х	0	Illegal, PD is set on POR
1	0	u	WDT Reset
1	0	0	WDT Wake-up
1	u	u	MCLR reset during normal operation
1	1	0	MCLR reset during SLEEP

TABLE 7-5: INITIALIZATION CONDITION FOR SPECIAL REGISTERS

Condition	Program Counter	STATUS Register	PCON Register
Power-on Reset	000h	0001 1xxx	0-
MCLR reset during normal operation	000h	000u uuuu	u-
MCLR reset during SLEEP	000h	0001 0uuu	u-
WDT reset	000h	0000 uuuu	u-
WDT Wake-up	PC + 1	uuu0 0uuu	u-
Interrupt Wake-up from SLEEP	PC + 1 ⁽¹⁾	uuul Ouuu	u-

Legend: u = unchanged, x = unknown, - = unimplemented bit, reads as '0'.

Note 1: When the wake-up is due to an interrupt and global enable bit, GIE is set, the PC is loaded with the interrupt vector (0004h) after execution of PC+1.

TABLE 7-6: INITIALIZATION CONDITION FOR REGISTERS

Register	Address	Power-on Reset	 MCLR Reset during normal operation MCLR Reset during SLEEP WDT Reset 	 Wake up from SLEEP through interrupt Wake up from SLEEP through WDT time-out
W	-	XXXX XXXX	uuuu uuuu	uuuu uuuu
INDF	00h	-	-	-
TMR0	01h	XXXX XXXX	uuuu uuuu	นนนน นนนน
PCL	02h	0000 0000	0000 0000	$PC + 1^{(2)}$
STATUS	03h	0001 1xxx	000q quuu ⁽³⁾	uuuq quuu ⁽³⁾
FSR	04h	XXXX XXXX	uuuu uuuu	uuuu uuuu
PORTA	05h	x xxxx	u uuuu	u uuuu
PORTB	06h	XXXX XXXX	uuuu uuuu	uuuu uuuu
PCLATH	0Ah	0 0000	0 0000	u uuuu
INTCON	0Bh	0000 000x	0000 000u	uuuu uuuu ⁽¹⁾
OPTION	81h	1111 1111	1111 1111	uuuu uuuu
TRISA	85h	1 1111	1 1111	u uuuu
TRISB	86h	1111 1111	1111 1111	นนนน นนนน
PCON	8Eh	0-	u-	u-

Legend: u = unchanged, x = unknown, - = unimplemented bit, reads as '0', q = value depends on condition.

Note 1: One or more bits in INTCON will be affected (to cause wake-up).

2: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

3: See Table 7-5 for reset value for specific condition.





FIGURE 7-9: TIME-OUT SEQUENCE ON POWER-UP (MCLR NOT TIED TO VDD): CASE 2



FIGURE 7-10: TIME-OUT SEQUENCE ON POWER-UP (MCLR TIED TO VDD): CASE 3



FIGURE 7-11: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW VDD POWER-UP)



7.5 Interrupts

The PIC16C55X has 3 sources of interrupt:

- External interrupt RB0/INT
- TMR0 overflow interrupt
- PortB change interrupts (pins RB7:RB4)

The interrupt control register (INTCON) records individual interrupt requests in flag bits. It also has individual and global interrupt enable bits.

A global interrupt enable bit, GIE (INTCON<7>) enables (if set) all un-masked interrupts or disables (if cleared) all interrupts. Individual interrupts can be disabled through their corresponding enable bits in INTCON register. GIE is cleared on reset.

The "return from interrupt" instruction, RETFIE, exits the interrupt routine as well as sets the GIE bit, which re-enables RB0/INT interrupts.

The INT pin interrupt, the RB port change interrupt and the TMR0 overflow interrupt flags are contained in the INTCON register.

When an interrupt is responded to, the GIE is cleared to disable any further interrupt, the return address is pushed into the stack and the PC is loaded with 0004h. Once in the interrupt service routine the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bit(s) must be cleared in software before re-enabling interrupts to avoid RB0/INT recursive interrupts. For external interrupt events, such as the INT pin or PORTB change interrupt, the interrupt latency will be three or four instruction cycles. The exact latency depends when the interrupt event occurs (Figure 7-13). The latency is the same for one or two cycle instructions. Once in the interrupt service routine the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bit(s) must be cleared in software before re-enabling interrupts to avoid multiple interrupt requests. Individual interrupt flag bits are set regardless of the status of their corresponding mask bit or the GIE bit.

- Note 1: Individual interrupt flag bits are set regardless of the status of their corresponding mask bit or the GIE bit.
 - 2: When an instruction that clears the GIE bit is executed, any interrupts that were pending for execution in the next cycle are ignored. The CPU will execute a NOP in the cycle immediately following the instruction which clears the GIE bit. The interrupts which were ignored are still pending to be serviced when the GIE bit is set again.



FIGURE 7-12: INTERRUPT LOGIC

7.5.1 **RB0/INT INTERRUPT**

An external interrupt on RB0/INT pin is edge triggered: either rising if INTEDG bit (OPTION<6>) is set, or falling if INTEDG bit is clear. When a valid edge appears on the RB0/INT pin, the INTF bit (INTCON<1>) is set. This interrupt can be disabled by clearing the INTE control bit (INTCON<4>). The INTF bit must be cleared in software in the interrupt service routine before re-enabling this interrupt. The RB0/INT interrupt can wake-up the processor from SLEEP, if the INTE bit was set prior to going into SLEEP. The status of the GIE bit decides whether or not the processor branches to the interrupt vector following wake-up. See Section 7.8 for details on SLEEP and Figure 7-16 for timing of wake-up from SLEEP through RB0/INT interrupt.

7.5.2 TMR0 INTERRUPT

An overflow (FFh \rightarrow 00h) in the TMR0 register will set the T0IF (INTCON<2>) bit. The interrupt can enabled/disabled by setting/clearing be T0IE (INTCON<5>) bit. For operation of the Timer0 module, see Section 6.0.

7.5.3 PORTB INTERRUPT

An input change on PORTB <7:4> sets the RBIF (INTCON<0>) bit. The interrupt can be enabled/disabled by setting/clearing the RBIE (INTCON<4>) bit. For operation of PORTB (Section 5.2).

Note: If a change on the I/O pin should occur when the read operation is being executed (start of the Q2 cycle), then the RBIF interrupt flag may get set.

: .	Q1 Q2 Q3 Q4 ;	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	[,] Q1 Q2 Q3 Q4
OSC1					
	(4)		[\/
INT pin			1 1 1	, , , ,	, 1 1 1
INTF flag (INTCON<1>)			Interrupt Latency (2)	1 1 1 1	1 1 1 1
GIE bit (INTCON<7>)	' i i			1 1 1	1 1 1
INSTRUCTION FL	<u>WO</u>			· · ·	
PC <	PC	PC+1	PC+1	0004h	0005h
Instruction { fetched	Inst (PC)	Inst (PC+1)	_	Inst (0004h)	Inst (0005h)
	Inst (PC-1)	Inst (PC)	Dummy Cycle	Dummy Cycle	Inst (0004h)
2: Interrupt Latency i 3: CLKOUT	is sampled here (evo latency = 3-4 Tcy wh s the same whether I is available only in R num width of INT put	ere Tcy = instruction Inst (PC) is a single c C oscillator mode.	cycle time. ycle or a 2-cycle instru	ction.	

FIGURE 7-13: INT PIN INTERRUPT TIMING

5: INTF is enabled to be set anytime during the Q4-Q1 cycles.

7.6 Context Saving During Interrupts

During an interrupt, only the return PC value is saved on the stack. Typically, users may wish to save key registers during an interrupt, e.g. W register and STATUS register. This will have to be implemented in software.

Example 7-1 stores and restores the STATUS and W registers. The user register, W_TEMP, must be defined in both banks and must be defined at the same offset from the bank base address (i.e., W_TEMP is defined at 0x20 in Bank 0 and it must also be defined at 0xA0 in Bank 1). The user register, STATUS_TEMP, must be defined in Bank 0. The Example 7-1:

- Stores the W register
- Stores the STATUS register in Bank 0
- Executes the ISR code
- Restores the STATUS (and bank select bit register)
- · Restores the W register

EXAMPLE 7-1: SAVING THE STATUS AND W REGISTERS IN RAM

MOVWF	W_TEMP	;copy W to temp register, ;could be in either bank
SWAPF	STATUS,W	;swap status to be saved into ${\tt W}$
BCF	STATUS, RPO	;change to bank 0 regardless ;of current bank
MOVWF	STATUS_TEMP	;save status to bank 0 ;register
:		
:	(ISR)	
:		
SWAPF	STATUS_TEMP,W	;swap STATUS_TEMP register ;into W, sets bank to original ;state
MOVWF	STATUS	;move W into STATUS register
SWAPF	W_TEMP,F	;swap W_TEMP
SWAPF	W_TEMP,W	;swap W_TEMP into W

7.7 <u>Watchdog Timer (WDT)</u>

The watchdog timer is a free running on-chip RC oscillator which does not require any external components. This RC oscillator is separate from the RC oscillator of the CLKIN pin. That means that the WDT will run, even if the clock on the OSC1 and OSC2 pins of the device has been stopped, for example, by execution of a SLEEP instruction. During normal operation, a WDT time-out generates a device RESET. If the device is in SLEEP mode, a WDT time-out causes the device to wake-up and continue with normal operation. The WDT can be permanently disabled by programming the configuration bit WDTE as clear (Section 7.1).

7.7.1 WDT PERIOD

The WDT has a nominal time-out period of 18 ms, (with no prescaler). The time-out periods vary with temperature, VDD and process variations from part to part (see DC specs). If longer time-out periods are desired, a prescaler with a division ratio of up to 1:128 can be assigned to the WDT under software control by writing to the OPTION register. Thus, time-out periods up to 2.3 seconds can be realized.

The CLRWDT and SLEEP instructions clear the WDT and the postscaler, if assigned to the WDT, and prevent it from timing out and generating a device RESET.

The $\overline{\text{TO}}$ bit in the STATUS register will be cleared upon a Watchdog Timer time-out.

7.7.2 WDT PROGRAMMING CONSIDERATIONS

It should also be taken in account that under worst case conditions (VDD = Min., Temperature = Max., max. WDT prescaler) it may take several seconds before a WDT time-out occurs.

FIGURE 7-14: WATCHDOG TIMER BLOCK DIAGRAM



FIGURE 7-15: SUMMARY OF WATCHDOG TIMER REGISTERS

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR	Value on all other Resets
2007h	Config. bits	—	+	CP1	CP0	PWRTE	WDTE	FOSC1	FOSC0		
81h	OPTION	RBPU	INTEDG	TOCS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111

Legend: Shaded cells are not used by the Watchdog Timer.

- = Unimplemented location, read as '0'.

+ = Reserved for future use.

7.8 Power-Down Mode (SLEEP)

The Power-down mode is entered by executing a SLEEP instruction.

If enabled, the Watchdog Timer will be cleared but keeps running, the PD bit in the STATUS register is cleared, the \overline{TO} bit is set, and the oscillator driver is turned off. The I/O ports maintain the status they had, before SLEEP was executed (driving high, low, or hi-impedance).

For lowest current consumption in this mode, all I/O pins should be either at VDD, or VSS, with no external circuitry drawing current from the I/O pin. I/O pins that are hi-impedance inputs should be pulled high or low externally to avoid switching currents caused by floating inputs. The TOCKI input should also be at VDD or Vss for lowest current consumption. The contribution from on chip pull-ups on PORTB should be considered.

The MCLR pin must be at a logic high level (VIHMC).

Note:	It should be noted that a RESET generated
	by a WDT time-out does not drive MCLR
	pin low.

7.8.1 WAKE-UP FROM SLEEP

The device can wake-up from SLEEP through one of the following events:

- 1. External reset input on MCLR pin
- Watchdog Timer Wake-up (if WDT was enabled) 2.
- 3 Interrupt from RB0/INT pin or RB Port change

The first event will cause a device reset. The two latter events are considered a continuation of program execution. The \overline{TO} and \overline{PD} bits in the STATUS register can be used to determine the cause of device reset. PD bit, which is set on power-up is cleared when SLEEP is invoked. TO bit is cleared if WDT Wake-up occurred.

When the SLEEP instruction is being executed, the next instruction (PC + 1) is pre-fetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be set (enabled). Wake-up is regardless of the state of the GIE bit. If the GIE bit is clear (disabled), the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is set (enabled), the device executes the instruction after the SLEEP instruction and then branches to the interrupt address (0004h). In cases where the execution of the instruction following SLEEP is not desirable, the user should have an NOP after the SLEEP instruction.

Note: If the global interrupts are disabled (GIE is cleared), but any interrupt source has both its interrupt enable bit and the corresponding interrupt flag bits set, the device will immediately wakeup from sleep. The sleep instruction is completely executed.

The WDT is cleared when the device wakes-up from sleep, regardless of the source of wake-up.

i i	Q1 Q2 Q3 Q4			1 Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	, Q1 Q2 Q3 Q4
			$\psi \cup \cup \cup \cup$			
CLKOUT(4)		TOST(2)	/	-∖/	//	·\/
INT pin			1	1	1	1
INTF flag			ı I	1		ı •
(INTCON<1>)			1	Interrupt Latency (Note 2)		! !
GIE bit (INTCON<7>)		Processor in	1	· \		1 1
		SLEEP	1	1	1	1 I
NSTRUCTION FLOW			1	1		1 1
PC X PC X	PC+1	Y PC+2	- V PC+2	PC + 2	X 0004h	v V 0005h
Instruction { fetched {	Inst(PC + 1)	1 1 1	Inst(PC + 2)	1 1 1	Inst(0004h)	Inst(0005h)
Instruction ∫ Inst(PC - 1)	SLEEP	1	Inst(PC + 1)	Dummy cycle	Dummy cycle	Inst(0004h)

FIGURE 7-16: WAKE-UP FROM SLEEP THROUGH INTERRUPT

GIE = '1' assumed. In this case after wake- up, the processor jumps to the interrupt routine. If GIE = '0', execution will continue in-line.

CLKOUT is not available in these osc modes, but shown here for timing reference.

7.9 <u>Code Protection</u>

If the code protection bit(s) have not been programmed, the on-chip program memory can be read out for verification purposes.

Note:	Microchip	does	not	recommend	code				
	protecting windowed devices.								

7.10 ID Locations

Four memory locations (2000h-2003h) are designated as ID locations where the user can store checksum or other code-identification numbers. These locations are not accessible during normal execution but are readable and writable during program/verify. Only the least significant 4 bits of the ID locations are used.

7.11 In-Circuit Serial Programming™

The PIC16C55X microcontrollers can be serially programmed while in the end application circuit. This is simply done with two lines for clock and data, and three other lines for power, ground, and the programming voltage. This allows customers to manufacture boards with unprogrammed devices, and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed.

The device is placed into a program/verify mode by holding the RB6 and RB7 pins low while raising the MCLR (VPP) pin from VIL to VIHH (see programming specification). RB6 becomes the programming clock and RB7 becomes the programming data. Both RB6 and RB7 are Schmitt Trigger inputs in this mode.

After reset, to place the device into programming/verify mode, the program counter (PC) is at location 00h. A 6-bit command is then supplied to the device. Depending on the command, 14-bits of program data are then supplied to or from the device, depending if the command was a load or a read. For complete details of serial programming, please refer to the PIC16C6X/7X Programming Specifications (Literature #DS30228).

A typical in-circuit serial programming connection is shown in Figure 7-17.

FIGURE 7-17: TYPICAL IN-CIRCUIT SERIAL PROGRAMMING CONNECTION



8.0 INSTRUCTION SET SUMMARY

Each PIC16C55X instruction is a 14-bit word divided into an OPCODE which specifies the instruction type and one or more operands which further specify the operation of the instruction. The PIC16C55X instruction set summary in Table 8-2 lists **byte-oriented**, **bit-oriented**, and **literal and control** operations. Table 8-1 shows the opcode field descriptions.

For **byte-oriented** instructions, 'f' represents a file register designator and 'd' represents a destination designator. The file register designator specifies which file register is to be used by the instruction.

The destination designator specifies where the result of the operation is to be placed. If 'd' is zero, the result is placed in the W register. If 'd' is one, the result is placed in the file register specified in the instruction.

For **bit-oriented** instructions, 'b' represents a bit field designator which selects the number of the bit affected by the operation, while 'f' represents the number of the file in which the bit is located.

For **literal and control** operations, 'k' represents an eight or eleven bit constant or literal value.

TABLE 8-1:OPCODE FIELD
DESCRIPTIONS

Field	Description
f	Register file address (0x00 to 0x7F)
W	Working register (accumulator)
b	Bit address within an 8-bit file register
k	Literal field, constant data or label
x	Don't care location (= 0 or 1) The assembler will generate code with $x = 0$. It is the recommended form of use for compatibility with all Microchip software tools.
d	Destination select; $d = 0$: store result in W, d = 1: store result in file register f. Default is $d = 1$
label	Label name
TOS	Top of Stack
PC	Program Counter
PCLATH	Program Counter High Latch
GIE	Global Interrupt Enable bit
WDT	Watchdog Timer/Counter
TO	Time-out bit
PD	Power-down bit
dest	Destination either the W register or the specified register file location
[]	Options
()	Contents
\rightarrow	Assigned to
<>	Register bit field
∈	In the set of
italics	User defined term (font is courier)

The instruction set is highly orthogonal and is grouped into three basic categories:

- Byte-oriented operations
- Bit-oriented operations
- Literal and control operations

All instructions are executed within one single instruction cycle, unless a conditional test is true or the program counter is changed as a result of an instruction. In this case, the execution takes two instruction cycles with the second cycle executed as a NOP. One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time is 1 μ s. If a conditional test is true or the program counter is changed as a result of an instruction, the instruction execution time is 2 μ s.

Table 8-1 lists the instructions recognized by the MPASM assembler.

Figure 8-1 shows the three general formats that the instructions can have.

Note:				compatibility	
	futu	ire PICmic	ro [®] produ	ucts, <u>do not us</u>	e the
	OPI	TION and T	RIS instru	uctions.	

All examples use the following format to represent a hexadecimal number:

0xhh

where h signifies a hexadecimal digit.

FIGURE 8-1: GENERAL FORMAT FOR INSTRUCTIONS



k = 11-bit immediate value

TABLE 8-2: PIC16C55X INSTRUCTION SET

Mnemonic, Operands		Description			14-Bit	Opcode	e	Status	Notes
				MSb			LSb	Affected	
BYTE-ORIE	NTED	FILE REGISTER OPERATIONS							
ADDWF	f, d	Add W and f	1	00	0111	dfff	ffff	C,DC,Z	1,2
ANDWF	f, d	AND W with f	1	00	0101	dfff	ffff	Z	1,2
CLRF	f	Clear f	1	00	0001	lfff	ffff	Z	2
CLRW	-	Clear W	1	00	0001	0000	0011	Z	
COMF	f, d	Complement f	1	00	1001	dfff	ffff	Z	1,2
DECF	f, d	Decrement f	1	00	0011	dfff	ffff	Z	1,2
DECFSZ	f, d	Decrement f, Skip if 0	1(2)	00	1011	dfff	ffff		1,2,3
INCF	f, d	Increment f	1	00	1010	dfff	ffff	Z	1,2
INCFSZ	f, d	Increment f, Skip if 0	1(2)	00	1111	dfff	ffff		1,2,3
IORWF	f, d	Inclusive OR W with f	1	00	0100	dfff	ffff	Z	1,2
MOVF	f, d	Move f	1	00	1000	dfff	ffff	Z	1,2
MOVWF	f	Move W to f	1	00	0000	lfff	ffff		
NOP	-	No Operation	1	00	0000	0xx0	0000		
RLF	f, d	Rotate Left f through Carry	1	00	1101	dfff	ffff	С	1,2
RRF	f, d	Rotate Right f through Carry	1	00	1100	dfff	ffff	С	1,2
SUBWF	f, d	Subtract W from f	1	00	0010	dfff	ffff	C,DC,Z	1,2
SWAPF	f, d	Swap nibbles in f	1	00	1110	dfff	ffff		1,2
XORWF	f, d	Exclusive OR W with f	1	00	0110	dfff	ffff	Z	1,2
BIT-ORIENT	ED FIL	E REGISTER OPERATIONS							
BCF	f, b	Bit Clear f	1	01	00bb	bfff	ffff		1,2
BSF	f, b	Bit Set f	1	01	01bb	bfff	ffff		1,2
BTFSC	f, b	Bit Test f, Skip if Clear	1 (2)	01	10bb	bfff	ffff		3
BTFSS	f, b	Bit Test f, Skip if Set	1 (2)	01	11bb	bfff	ffff		3
LITERAL A	ND CO	NTROL OPERATIONS							
ADDLW	k	Add literal and W	1	11	111x	kkkk	kkkk	C,DC,Z	
ANDLW	k	AND literal with W	1	11	1001	kkkk	kkkk	Z	
CALL	k	Call subroutine	2	10	0kkk	kkkk	kkkk		
CLRWDT	-	Clear Watchdog Timer	1	00	0000	0110	0100	TO,PD	
GOTO	k	Go to address	2	10	1kkk	kkkk	kkkk		
IORLW	k	Inclusive OR literal with W	1	11	1000	kkkk	kkkk	Z	
MOVLW	k	Move literal to W	1	11	00xx	kkkk	kkkk		
RETFIE	-	Return from interrupt	2	00	0000	0000	1001		
RETLW	k	Return with literal in W	2	11	01xx	kkkk	kkkk		
RETURN	-	Return from Subroutine	2	00	0000	0000	1000		
SLEEP	-	Go into standby mode	1	00	0000	0110	0011	TO,PD	
SUBLW	k	Subtract W from literal	1	11	110x	kkkk	kkkk	C,DC,Z	
		1	1	1					1

Note 1: When an I/O register is modified as a function of itself (e.g., MOVF PORTB, 1), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned to the Timer0 Module.

3: If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

8.1 Instruction Descriptions

ADDLW	Add Literal and W					
Syntax:	[<i>label</i>] ADDLW k					
Operands:	$0 \le k \le 25$	55				
Operation:	(W) + k –	→ (W)				
Status Affected:	C, DC, Z					
Encoding:	11	111x	kkkk	kkkk		
Description:	The contents of the W register are added to the eight bit literal 'k' and the result is placed in the W register.					
Words:	1					
Cycles:	1					
Example	ADDLW	0x15				
	After Inst	W =	0x10 0x25			

ANDLW	AND Literal with W				
Syntax:	[<i>label</i>] ANDLW k				
Operands:	$0 \le k \le 255$				
Operation:	(W) .AND. (k) \rightarrow (W)				
Status Affected:	Z				
Encoding:	11 1001 kkkk kkkk				
Description:	The contents of W register are AND'ed with the eight bit literal 'k'. The result is placed in the W register.				
Words:	1				
Cycles:	1				
Example	ANDLW 0x5F				
	Before Instruction W = 0xA3 After Instruction W = 0x03				

ADDWF	Add W and f				
Syntax:	[label] ADDWF f,d				
Operands:	$0 \le f \le 127$ $d \in [0,1]$				
Operation:	$(W) + (f) \to (dest)$				
Status Affected:	C, DC, Z				
Encoding:	00 0111 dfff ffff				
Description:	Add the contents of the W register with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.				
Words:	1				
Cycles:	1				
Example	ADDWF FSR, 0				
	Before Instruction W = 0x17 FSR = 0xC2 After Instruction W = 0xD9 FSR = 0xC2				

ANDWF	AND W with f
Syntax:	[label] ANDWF f,d
Operands:	$0 \le f \le 127$ $d \in [0,1]$
Operation:	(W) .AND. (f) \rightarrow (dest)
Status Affected:	Z
Encoding:	00 0101 dfff ffff
Description:	AND the W register with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.
Words:	1
Cycles:	1
Example	ANDWF FSR, 1
	Before Instruction W = 0x17 FSR = 0xC2 After Instruction W = 0x17 FSR = 0x02

BCF	Bit Clear	f				
Syntax:	[<i>label</i>] BCF f,b					
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ 0 \leq b \leq 7 \end{array}$					
Operation:	$0 \rightarrow (f < b;$	>)				
Status Affected:	None					
Encoding:	01	00bb	bfff	ffff		
Description:	Bit 'b' in re	gister 'f' is	s cleared.			
Words:	1					
Cycles:	1					
Example	BCF	FLAG_	REG, 7			
	Before Instruction FLAG_REG = 0xC7 After Instruction FLAG_REG = 0x47					

BTFSC	Bit Test, Skip if Clear						
Syntax:	[<i>label</i>] E	[label] BTFSC f,b					
Operands:		$0 \le f \le 127$ $0 \le b \le 7$					
Operation:	skip if (f<	:b>) = 0					
Status Affected:	None						
Encoding:	01	10bb	bfff	ffff			
Description:	instructior If bit 'b' is fetched du execution executed	If bit 'b' in register 'f' is '0' then the next instruction is skipped. If bit 'b' is '0' then the next instruction fetched during the current instruction execution is discarded, and a NOP is executed instead, making this a two-cycle instruction.					
Words:	1						
Cycles:	1(2)						
Example	HERE FALSE TRUE	BTFSC GOTO • •	FLAG,1 PROCESS_	_CODE			
	Before Ir	struction					
	A (1 1		ddress H	ERE			
	After Inst	if FLAG<1>	address T	RUE			
			address F.	ALSE			

BSF	Bit Set f						
Syntax:	[label] B	[<i>label</i>] BSF f,b					
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ 0 \leq b \leq 7 \end{array}$						
Operation:	$1 \rightarrow (f < b >)$						
Status Affected:	Status Affected: None						
Encoding:	01	01bb	bfff	ffff			
Description:	Bit 'b' in re	gister 'f' is	s set.				
Words:	1						
Cycles:	1						
Example	BSF	FLAG_F	REG, 7				
	Before Instruction FLAG_REG = 0x0A After Instruction FLAG_REG = 0x8A						

BTFSS	Bit Test f, Skip if Set					
Syntax:	[<i>label</i>] BTFSS f,b					
Operands:	$0 \le f \le 127$ $0 \le b < 7$					
Operation:	skip if (f) = 1					
Status Affected:	None					
Encoding:	01 11bb bfff ffff					
Description:	If bit 'b' in register 'f' is '1' then the next instruction is skipped. If bit 'b' is '1', then the next instruction fetched during the current instruction execution, is discarded and a NOP is executed instead, making this a two-cycle instruction.					
Words:	1					
Cycles:	1(2)					
Example	HERE BTFSS FLAG,1 FALSE GOTO PROCESS_CODE TRUE • • •					
	Before Instruction PC = address HERE After Instruction					
	if FLAG<1> = 0, PC = address FALSE if FLAG<1> = 1, PC = address TRUE					

CLRF	Clear f				
Syntax:	[label] Cl	LRF f			
Operands:	$0 \le f \le 127$				
Operation:	$\begin{array}{l} 00h \rightarrow (f) \\ 1 \rightarrow Z \end{array}$				
Status Affected:	Z				
Encoding:	00	0001	lfff	ffff	
Description:	The content and the Z bi		ster 'f' are	cleared	
Words:	1				
Cycles:	1				
Example	CLRF	FLAG	_REG		
	Before Instruction FLAG_REG = 0x5A After Instruction FLAG_REG = 0x00 Z = 1				

CALL	Call Subroutine				
Syntax:	[<i>label</i>] CALL k				
Operands:	$0 \le k \le 2047$				
Operation:	(PC)+ 1 \rightarrow TOS, k \rightarrow PC<10:0>, (PCLATH<4:3>) \rightarrow PC<12:11>				
Status Affected:	None				
Encoding:	10 0kkk kkkk kkkk				
Description:	Call Subroutine. First, return address (PC+1) is pushed onto the stack. The eleven bit immediate address is loaded into PC bits <10:0>. The upper bits of the PC are loaded from PCLATH. CALL is a two-cycle instruction.				
Words:	1				
Cycles:	2				
Example	HERE CALL THERE				
	Before Instruction PC = Address HERE After Instruction PC = Address THERE TOS = Address HERE+1				

CLRW	Clear W				
Syntax:	[label] CLRW				
Operands:	None				
Operation:	$\begin{array}{l} 00h \rightarrow (W) \\ 1 \rightarrow Z \end{array}$				
Status Affected:	Z				
Encoding:	00 0001 0000 001	1			
Description:	W register is cleared. Zero bit (Z) is set.				
Words:	1				
Cycles:	1				
Example	CLRW				
	Before Instruction W = 0x5A				
	After Instruction				
	W = 0x00 $Z = 1$				

CLRWDT	Clear Watchdog Timer					
Syntax:	[label] CLRWDT					
Operands:	None					
Operation:	$\begin{array}{l} 00h \rightarrow WDT \\ 0 \rightarrow WDT \text{ prescaler,} \\ 1 \rightarrow \overline{TO} \\ 1 \rightarrow \overline{PD} \end{array}$					
Status Affected:	TO, PD					
Encoding:	00 0000 0110 0100					
Description:	CLRWDT instruction resets the Watchdog Timer. It also resets the prescaler of the WDT. Status bits TO and PD are set.					
Words:	1					
Cycles:	1					
Example	CLRWDT					
	Before Instruction WDT counter = ? After Instruction WDT counter = $0x00$ WDT prescaler = 0 \overline{TO} = 1 \overline{PD} = 1					
COMF	Complement f					
Syntax:	[label] COMF f,d					
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in \ [0,1] \end{array}$					
Operation:	$(\overline{f}) \rightarrow (dest)$					
Status Affected:	Z					
Encoding:	00 1001 dfff ffff					
Description:	The contents of register 'f' are complemented. If 'd' is 0 the result is stored in W. If 'd' is 1 the result is stored back in register 'f'.					
Words:	1					

DECF	Decremer	nt f				
Syntax:	[label] D	[label] DECF f,d				
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in \ [0,1] \end{array}$	$0 \le f \le 127$ $d \in [0,1]$				
Operation:	(f) - 1 \rightarrow (c	dest)				
Status Affected:	Z					
Encoding:	00	0011	dfi	Ef	ffff	
Description:	Decrement register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.					
Words:	1					
Cycles:	1					
Example	DECF	CNT,	1			
	Z After Instru	NT uction	= = =	0x01 0 0x00 1		

COMF	Compler	nent f					DEC
Syntax:	[label]	COMF	f,d			I	Syn
Operands:	$0 \le f \le 12$ $d \in [0,1]$	27					Оре
Operation:	$(\bar{f}) \to (de$	st)					Ope
Status Affected:	Z						Stat
Encoding:	00	1001	df	ff	ffff		Enc
Description:	The conte compleme stored in V stored bac	nted. If 'd V. If 'd' is	' is 0 1 the	the resul	esult is		Des
Words:	1						
Cycles:	1						
Example	COMF	REC	G1,0				Wor
	Before In		ı				Сус
	After Inst	REG1 ruction	=	0x13	3		Exa
		REG1	=	0x13	3		
		W	=	0xE0	C		

DECFSZ	Decrement f, Skip if 0				
Syntax:	[label] DECFSZ f,d				
Operands:	0 ≤ f ≤ 127 d ∈ [0,1]				
Operation:	(f) - 1 \rightarrow (dest); skip if result = 0				
Status Affected:	None				
Encoding:	00 1011 dfff ffff				
Description:	The contents of register 'f' are decremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'. If the result is 0, the next instruction, which is already fetched, is discarded. A NOP is executed instead making it a two-cycle instruction.				
Words:	1				
Cycles:	1(2)				
Example	HERE DECFSZ CNT, 1 GOTO LOOP CONTINUE • •				
	$\begin{array}{rcl} Before \ Instruction \\ PC &= & address \ {} {}_{HERE} \\ After \ Instruction \\ CNT &= & CNT - 1 \\ if \ CNT &= & 0, \\ PC &= & address \ CONTINUE \\ if \ CNT \neq & 0, \\ PC &= & address \ {}_{HERE+1} \\ \end{array}$				

GOTO	Unconditional Branch	INCFSZ	Increment f, Skip if 0
Syntax:	[<i>label</i>] GOTO k	Syntax:	[<i>label</i>] INCFSZ f,d
Operands:	$0 \le k \le 2047$	Operands:	$0 \le f \le 127$
Operation:	$k \rightarrow PC < 10:0>$		d ∈ [0,1]
	$PCLATH<4:3> \rightarrow PC<12:11>$	Operation:	(f) + 1 \rightarrow (dest), skip if result = 0
Status Affected:	None	Status Affected:	None
Encoding:	10 1kkk kkkk kkkk	Encoding:	00 1111 dfff ffff
Description: Words:	GOTO is an unconditional branch. The eleven bit immediate value is loaded into PC bits <10:0>. The upper bits of PC are loaded from PCLATH<4:3>. GOTO is a two-cycle instruction.	Description:	The contents of register 'f' are incremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'. If the result is 0, the next instruction, which is already fetched, is discarded. A NOP is executed instead making it a two-cycle instruction.
Cycles:	2	Words:	1
Example	GOTO THERE	Cycles:	1(2)
	After Instruction PC = Address THERE	Example	HERE INCFSZ CNT, 1 GOTO LOOP CONTINUE • •
			Before Instruction

Delote III	Siluc	
PC	=	address HERE
After Inst	ructi	on
CNT	=	CNT + 1
if CNT	=	0,
PC	=	address CONTINUE
if CNT	≠	0,
PC	=	address HERE +1

INCF	Increment f				
Syntax:	[label] INCF f,d				
Operands:	0 ≤ f ≤ 127 d ∈ [0,1]				
Operation:	(f) + 1 \rightarrow (dest)				
Status Affected:	Z				
Encoding:	00 1010 dfff ffff				
Description:	The contents of register 'f' are incremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.				
Words:	1				
Cycles:	1				
Example	INCF CNT, 1				
	Before Instruction CNT = 0xFF Z = 0 After Instruction CNT = 0x00 Z = 1				

IORLW	Inclusive OR Literal with W			
Syntax:	[<i>label</i>] IORLW k			
Operands:	$0 \le k \le 255$			
Operation:	(W) .OR. $k \rightarrow$ (W)			
Status Affected:	Z			
Encoding:	11 1000 kkkk kkkk			
Description:	The contents of the W register is OR'ed with the eight bit literal 'k'. The result is placed in the W register.			
Words:	1			
Cycles:	1			
Example	IORLW 0x35			
	Before Instruction W = 0x9A After Instruction W = 0xBF Z = 1			

IORWF	Inclusive OR W with f				
Syntax:	[label]	IORWF	f,d		
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in \left[0,1\right] \end{array}$				
Operation:	(W) .OR.	$(f) \rightarrow (de)$	est)		
Status Affected:	Z				
Encoding:	00	0100	dff	f	ffff
Description:	Inclusive C register 'f'. in the W re placed bac	If 'd' is 0 t egister. If '	he res d' is 1	sult is the i	placed
Words:	1				
Cycles:	1				
Example	IORWF		RESU	LT,	0
	After Inst	RESULT W	=	0x13 0x91 0x13 0x93 1	i

MOVLW	Move Literal to W				
Syntax:	[<i>label</i>] MOVLW k				
Operands:	$0 \le k \le 25$	55			
Operation:	$k\to(W)$				
Status Affected:	None				
Encoding:	11	00xx	kkkk	kkkk	
Description:	The eight bit literal 'k' is loaded into W register. The don't cares will assemble as 0's.				
Words:	1				
Cycles:	1				
Example	MOVLW	0x5A			
	After Inst	ruction W =	0x5A		

MOVF	Move f
Syntax:	[<i>label</i>] MOVF f,d
Operands:	$0 \le f \le 127$ $d \in [0,1]$
Operation:	(f) \rightarrow (dest)
Status Affected:	Z
Encoding:	00 1000 dfff ffff
Description:	The contents of register f is moved to a destination dependant upon the status of d. If $d = 0$, destination is W register. If $d = 1$, the destination is file register f itself. $d = 1$ is useful to test a file register since status flag Z is affected.
Words:	1
Cycles:	1
Example	MOVF FSR, 0
	After Instruction W = value in FSR register Z = 1

MOVWF	Move W to f
Syntax:	[label] MOVWF f
Operands:	$0 \le f \le 127$
Operation:	$(W) \rightarrow (f)$
Status Affected:	None
Encoding:	00 0000 1fff ffff
Description:	Move data from W register to register 'f'.
Words:	1
Cycles:	1
Example	MOVWF OPTION
	Before Instruction OPTION = 0xFF W = 0x4F After Instruction OPTION = 0x4F W = 0x4F

NOP	No Operation	ation		
Syntax:	[label]	NOP		
Operands:	None			
Operation:	No opera	ition		
Status Affected:	None			
Encoding:	00	0000	0xx0	0000
Description:	No operati	ion.		
Words:	1			
Cycles:	1			
Example	NOP			

RETFIE	Return from Interrupt
Syntax:	[label] RETFIE
Operands:	None
Operation:	$\begin{array}{l} \text{TOS} \rightarrow \text{PC}, \\ 1 \rightarrow \text{GIE} \end{array}$
Status Affected:	None
Encoding:	00 0000 0000 1001
Description:	Return from Interrupt. Stack is POPed and Top of Stack (TOS) is loaded in the PC. Interrupts are enabled by setting Global Interrupt Enable bit, GIE (INTCON<7>). This is a two-cycle instruction.
Words:	1
Cycles:	2
Example	RETFIE
	After Interrupt PC = TOS GIE = 1

OPTION	Load Op	tion Reg	gister	
Syntax:	[label]	OPTION	١	
Operands:	None			
Operation:	$(W)\toO$	PTION		
Status Affected:	None			
Encoding:	00	0000	0110	0010
Description:	The conte loaded in t instruction compatibil Since OPT register, th address it.	he OPTIC is suppor ity with PI FION is a re user ca	DN register rted for coo C16C5X p readable/v	r. This de products.
Words:	1			
Cycles:	1			
Example				
	with futu	re PICmi	rd compa cro™ proo struction.	ducts,

RETLW	Return with Literal in W
Syntax:	[<i>label</i>] RETLW k
Operands:	$0 \le k \le 255$
Operation:	$k \rightarrow (W);$ TOS $\rightarrow PC$
Status Affected:	None
Encoding:	11 01xx kkkk kkkk
Description:	The W register is loaded with the eight bit literal 'k'. The program counter is loaded from the top of the stack (the return address). This is a two-cycle instruction.
Words:	1
Cycles:	2
Example	CALL TABLE ;W contains table ;offset value . ;W now has table value
TABLE	ADDWF PC ;W = offset RETIW k1 ;Begin table RETLW k2 ;
	Before Instruction
	W = 0x07 After Instruction
	W = value of k8

RETURN	Return from Subroutine	RRF	Rotate Right f through Carry
Syntax:	[label] RETURN	Syntax:	[<i>label</i>] RRF f,d
Operands:	None	Operands:	$0 \le f \le 127$
Operation:	$TOS\toPC$		d ∈ [0,1]
Status Affected:	None	Operation:	See description below
Encoding:	00 0000 0000 1000	Status Affected:	С
Description:	Return from subroutine. The stack is	Encoding:	00 1100 dfff ffff
Words:	POPed and the top of the stack (TOS) is loaded into the program counter. This is a two cycle instruction. 1	Description:	The contents of register 'f' are rotated one bit to the right through the Carry Flag. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is
Cycles:	2		placed back in register 'f'.
Example	RETURN		C Register f
	After Interrupt	Words:	1
	PC = TOS	Cycles:	1
		Example	RRF REG1,0
			Before Instruction REG1 = 1110 0110 C = 0 After Instruction REG1 = 1110 0110 W = 0111 0011 C = 0 0

RLF	Rotate Left f through Carry	SLEEP
Syntax:	[<i>label</i>] RLF f,d	Syntax:
Operands:	$0 \le f \le 127$ d $\in [0,1]$	Operand
Operation:	See description below	Operatio
Status Affected:	С	
Encoding:	00 1101 dfff ffff	
Description:	The contents of register 'f' are rotated one bit to the left through the Carry Flag. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is stored back in register 'f'.	Encodin <u>(</u> Descripti
Words:	1	
Cycles:	1	
Example	RLF REG1,0	Words:
	Before Instruction	Cycles:
	REG1 = 1110 0110 C = 0	Example
	After Instruction	
	$\begin{array}{rcl} REG1 &=& 1110 & 0110 \\ W &=& 1100 & 1100 \\ C &=& 1 \end{array}$	

Syntax:	[label]	SLEEF)	
Operands:	None			
Operation:	$\begin{array}{l} 00h \rightarrow V\\ 0 \rightarrow WD\\ 1 \rightarrow \overline{TO},\\ 0 \rightarrow \overline{PD} \end{array}$,	aler,	
Status Affected:	TO, PD			
Encoding:	00	0000	0110	0011
Description:	The power cleared. T set. Watcl prescaler The proce mode with See Secti	ime-out s ndog Time are clear essor is pr n the oscil	tatus bit, [†] er and its ed. ut into SLI llator stop	TO is EEP ped.
Words:	1			
Cycles:	1			
Example:	SLEEP			

SUBLW	Subtract W from Literal	SUBWF	Subtract W from f	
Syntax:	[<i>label</i>] SUBLW k	Syntax:	[<i>label</i>] SUBWF f,d	
Operands:	$0 \le k \le 255$	Operands:	$0 \le f \le 127$	
Operation:	$k \text{ - } (W) \to (W)$		d ∈ [0,1]	
Status	C, DC, Z	Operation:	(f) - (W) \rightarrow (dest)	
Affected:		Status	C, DC, Z	
Encoding:	11 110x kkkk kkkk	Affected:		
Description:	The W register is subtracted (2's com-	Encoding:	00 0010 dfff ffff	
	plement method) from the eight bit literal 'k'. The result is placed in the W register.	Description:	Subtract (2's complement method) W register from register 'f'. If 'd' is 0 the	
Words:	1		result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.	
Cycles:	1	Words:	1	
Example 1:	SUBLW 0x02	Cycles:	1	
	Before Instruction	Example 1:	SUBWF REG1,1	
	W = 1	Example 1.	Before Instruction	
	C = ?		REG1 = 3	
	After Instruction		W = 2	
	W = 1 C = 1; result is posi-		C = ?	
	tive		After Instruction	
Example 2:	Before Instruction		REG1 = 1 W = 2	
	W = 2 $C = 2$		C = 1; result is positive	
		Example 2:	Before Instruction	
	After Instruction		REG1 = 2	
	W = 0 C = 1; result is zero		W = 2 $C = 2$	
Example 3:	Before Instruction		After Instruction	
·	W = 3		REG1 = 0	
	C = ?		W = 2	
	After Instruction		C = 1; result is zero	
	W = 0xFF	Example 3:	Before Instruction	
	C = 0; result is nega- tive		REG1 = 1 W = 2	
			C = ?	
			After Instruction	
			REG1 = 0xFF	
			W = 2 C = 0; result is negative	

SWAPF	Swap Nibbles in f
Syntax:	[label] SWAPF f,d
Operands:	$0 \le f \le 127$ $d \in [0,1]$
Operation:	$(f<3:0>) \rightarrow (dest<7:4>), (f<7:4>) \rightarrow (dest<3:0>)$
Status Affected:	None
Encoding:	00 1110 dfff ffff
Description:	The upper and lower nibbles of register 'f' are exchanged. If 'd' is 0 the result is placed in W register. If 'd' is 1 the result is placed in register 'f'.
Words:	1
Cycles:	1
Example	SWAPF REG, 0
	Before Instruction
	REG1 = 0xA5
	After Instruction
	REG1 = 0xA5 W = 0x5A

XORLW	Exclusive OR Literal with W
Syntax:	[label] XORLW k
Operands:	$0 \le k \le 255$
Operation:	(W) .XOR. $k \rightarrow (W)$
Status Affected:	Z
Encoding:	11 1010 kkkk kkkk
Description:	The contents of the W register are XOR'ed with the eight bit literal 'k'. The result is placed in the W register.
Words:	1
Cycles:	1
Example:	XORLW 0xAF
	Before Instruction
	W = 0xB5
	After Instruction
	W = 0x1A

TRIS	Load TRIS Register					
Syntax:	[label]	TRIS	f			
Operands:	$5 \le f \le 7$					
Operation:	$(W) \rightarrow TF$	RIS regis	ster f;			
Status Affected:	None					
Encoding:	00	0000	0110	Offf		
Description: Words:	The instruction is supported for code compatibility with the PIC16C5X products. Since TRIS registers are readable and writable, the user can directly address them. 1					
Cycles: Example	1					
	To maintain upward compatibility with future PICmicro™ products, do not use this instruction.					

XORWF	Exclusive OR W with f							
Syntax:	[label]	XORWF	f,d					
Operands:	0 ≤ f ≤ 127 d ∈ [0,1]							
Operation:	(W) .XOF	R. (f) \rightarrow (c	lest)					
Status Affected:	Z							
Encoding:	00	0110	dfff	f	fff			
Description:	Exclusive OR the contents of the W register with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.							
Words:	1							
Cycles:	1							
Example	XORWF	REG	1					
	Before Instruction							
		REG W	= =	0xAF 0xB5				
	After Inst	ruction						
		REG W	= =	0x1A 0xB5				

9.0 DEVELOPMENT SUPPORT

9.1 <u>Development Tools</u>

The PICmicro[®] microcontrollers are supported with a full range of hardware and software development tools:

- MPLAB[™]-ICE Real-Time In-Circuit Emulator
- ICEPIC[™] Low-Cost PIC16C5X and PIC16CXXX In-Circuit Emulator
- PRO MATE[®] II Universal Programmer
- PICSTART[®] Plus Entry-Level Prototype Programmer
- SIMICE
- PICDEM-1 Low-Cost Demonstration Board
- PICDEM-2 Low-Cost Demonstration Board
- PICDEM-3 Low-Cost Demonstration Board
- MPASM Assembler
- MPLAB[™] SIM Software Simulator
- MPLAB-C17 (C Compiler)
- Fuzzy Logic Development System (*fuzzy*TECH[®]–MP)
- KEELOQ[®] Evaluation Kits and Programmer

9.2 <u>MPLAB-ICE: High Performance</u> <u>Universal In-Circuit Emulator with</u> <u>MPLAB IDE</u>

The MPLAB-ICE Universal In-Circuit Emulator is intended to provide the product development engineer with a complete microcontroller design tool set for PICmicro microcontrollers (MCUs). MPLAB-ICE is supplied with the MPLAB Integrated Development Environment (IDE), which allows editing, "make" and download, and source debugging from a single environment.

Interchangeable processor modules allow the system to be easily reconfigured for emulation of different processors. The universal architecture of the MPLAB-ICE allows expansion to support all new Microchip microcontrollers.

The MPLAB-ICE Emulator System has been designed as a real-time emulation system with advanced features that are generally found on more expensive development tools. The PC compatible 386 (and higher) machine platform and Microsoft Windows[®] 3.x or Windows 95 environment were chosen to best make these features available to you, the end user.

MPLAB-ICE is available in two versions. MPLAB-ICE 1000 is a basic, low-cost emulator system with simple trace capabilities. It shares processor modules with the MPLAB-ICE 2000. This is a full-featured emulator system with enhanced trace, trigger, and data monitoring features. Both systems will operate across the entire operating speed reange of the PICmicro MCU.

9.3 ICEPIC: Low-Cost PICmicro In-Circuit Emulator

ICEPIC is a low-cost in-circuit emulator solution for the Microchip PIC12CXXX, PIC16C5X and PIC16CXXX families of 8-bit OTP microcontrollers.

ICEPIC is designed to operate on PC-compatible machines ranging from 386 through Pentium[™] based machines under Windows 3.x, Windows 95, or Windows NT environment. ICEPIC features real time, non-intrusive emulation.

9.4 PRO MATE II: Universal Programmer

The PRO MATE II Universal Programmer is a full-featured programmer capable of operating in stand-alone mode as well as PC-hosted mode. PRO MATE II is CE compliant.

The PRO MATE II has programmable VDD and VPP supplies which allows it to verify programmed memory at VDD min and VDD max for maximum reliability. It has an LCD display for displaying error messages, keys to enter commands and a modular detachable socket assembly to support various package types. In standalone mode the PRO MATE II can read, verify or program PIC12CXXX, PIC14C000, PIC16C5X, PIC16CXXX and PIC17CXX devices. It can also set configuration and code-protect bits in this mode.

9.5 <u>PICSTART Plus Entry Level</u> <u>Development System</u>

The PICSTART programmer is an easy-to-use, low-cost prototype programmer. It connects to the PC via one of the COM (RS-232) ports. MPLAB Integrated Development Environment software makes using the programmer simple and efficient. PICSTART Plus is not recommended for production programming.

PICSTART Plus supports all PIC12CXXX, PIC14C000, PIC16C5X, PIC16CXXX and PIC17CXX devices with up to 40 pins. Larger pin count devices such as the PIC16C923, PIC16C924 and PIC17C756 may be supported with an adapter socket. PICSTART Plus is CE compliant.

9.6 <u>SIMICE Entry-Level Hardware</u> <u>Simulator</u>

SIMICE is an entry-level hardware development system designed to operate in a PC-based environment with Microchip's simulator MPLAB[™]-SIM. Both SIM-ICE and MPLAB-SIM run under Microchip Technology's MPLAB Integrated Development Environment (IDE) software. Specifically, SIMICE provides hardware simulation for Microchip's PIC12C5XX, PIC12CE5XX, and PIC16C5X families of PICmicro 8-bit microcontrollers. SIMICE works in conjunction with MPLAB-SIM to provide non-real-time I/O port emulation. SIMICE enables a developer to run simulator code for driving the target system. In addition, the target system can provide input to the simulator code. This capability allows for simple and interactive debugging without having to manually generate MPLAB-SIM stimulus files. SIMICE is a valuable debugging tool for entry-level system development.

9.7 <u>PICDEM-1 Low-Cost PICmicro</u> <u>Demonstration Board</u>

The PICDEM-1 is a simple board which demonstrates the capabilities of several of Microchip's microcontrollers. The microcontrollers supported are: PIC16C5X (PIC16C54 to PIC16C58A), PIC16C61, PIC16C62X, PIC16C71, PIC16C8X, PIC17C42, PIC17C43 and PIC17C44. All necessary hardware and software is included to run basic demo programs. The users can program the sample microcontrollers provided with the PICDEM-1 board, on a PRO MATE II or PICSTART-Plus programmer, and easily test firmware. The user can also connect the PICDEM-1 board to the MPLAB-ICE emulator and download the firmware to the emulator for testing. Additional prototype area is available for the user to build some additional hardware and connect it to the microcontroller socket(s). Some of the features include an RS-232 interface, a potentiometer for simulated analog input, push-button switches and eight LEDs connected to PORTB.

9.8 PICDEM-2 Low-Cost PIC16CXX Demonstration Board

The PICDEM-2 is a simple demonstration board that supports the PIC16C62, PIC16C64, PIC16C65, PIC16C73 and PIC16C74 microcontrollers. All the necessary hardware and software is included to run the basic demonstration programs. The user can program the sample microcontrollers provided with the PICDEM-2 board, on a PRO MATE II programmer or PICSTART-Plus, and easily test firmware. The MPLAB-ICE emulator may also be used with the PICDEM-2 board to test firmware. Additional prototype area has been provided to the user for adding additional hardware and connecting it to the microcontroller socket(s). Some of the features include a RS-232 interface, push-button switches, a potentiometer for simulated analog input, a Serial EEPROM to demonstrate usage of the I²C bus and separate headers for connection to an LCD module and a keypad.

9.9 PICDEM-3 Low-Cost PIC16CXXX Demonstration Board

The PICDEM-3 is a simple demonstration board that supports the PIC16C923 and PIC16C924 in the PLCC package. It will also support future 44-pin PLCC microcontrollers with a LCD Module. All the necessary hardware and software is included to run the basic demonstration programs. The user can program the sample microcontrollers provided with the PICDEM-3 board, on a PRO MATE II programmer or PICSTART Plus with an adapter socket, and easily test firmware. The MPLAB-ICE emulator may also be used with the PICDEM-3 board to test firmware. Additional prototype area has been provided to the user for adding hardware and connecting it to the microcontroller socket(s). Some of the features include an RS-232 interface, push-button switches, a potentiometer for simulated analog input, a thermistor and separate headers for connection to an external LCD module and a keypad. Also provided on the PICDEM-3 board is an LCD panel, with 4 commons and 12 segments, that is capable of displaying time, temperature and day of the week. The PICDEM-3 provides an additional RS-232 interface and Windows 3.1 software for showing the demultiplexed LCD signals on a PC. A simple serial interface allows the user to construct a hardware demultiplexer for the LCD signals.

9.10 <u>MPLAB Integrated Development</u> <u>Environment Software</u>

The MPLAB IDE Software brings an ease of software development previously unseen in the 8-bit microcontroller market. MPLAB is a windows based application which contains:

- A full featured editor
- Three operating modes
 - editor
 - emulator
 - simulator
- A project manager
- Customizable tool bar and key mapping
- A status bar with project information
- Extensive on-line help

MPLAB allows you to:

- Edit your source files (either assembly or 'C')
- One touch assemble (or compile) and download to PICmicro tools (automatically updates all project information)
- Debug using:
 - source files
 - absolute listing file

The ability to use MPLAB with Microchip's simulator allows a consistent platform and the ability to easily switch from the low cost simulator to the full featured emulator with minimal retraining due to development tools.

9.11 Assembler (MPASM)

The MPASM Universal Macro Assembler is a PC-hosted symbolic assembler. It supports all microcontroller series including the PIC12C5XX, PIC14000, PIC16C5X, PIC16CXXX, and PIC17CXX families.

MPASM offers full featured Macro capabilities, conditional assembly, and several source and listing formats. It generates various object code formats to support Microchip's development tools as well as third party programmers.

MPASM allows full symbolic debugging from MPLAB-ICE, Microchip's Universal Emulator System.

MPASM has the following features to assist in developing software for specific use applications.

- Provides translation of Assembler source code to object code for all Microchip microcontrollers.
- Macro assembly capability.
- Produces all the files (Object, Listing, Symbol, and special) required for symbolic debug with Microchip's emulator systems.
- Supports Hex (default), Decimal and Octal source and listing formats.

MPASM provides a rich directive language to support programming of the PICmicro. Directives are helpful in making the development of your assemble source code shorter and more maintainable.

9.12 Software Simulator (MPLAB-SIM)

The MPLAB-SIM Software Simulator allows code development in a PC host environment. It allows the user to simulate the PICmicro series microcontrollers on an instruction level. On any given instruction, the user may examine or modify any of the data areas or provide external stimulus to any of the pins. The input/output radix can be set by the user and the execution can be performed in; single step, execute until break, or in a trace mode.

MPLAB-SIM fully supports symbolic debugging using MPLAB-C17 and MPASM. The Software Simulator offers the low cost flexibility to develop and debug code outside of the laboratory environment making it an excellent multi-project software development tool.

9.13 MPLAB-C17 Compiler

The MPLAB-C17 Code Development System is a complete ANSI 'C' compiler and integrated development environment for Microchip's PIC17CXXX family of microcontrollers. The compiler provides powerful integration capabilities and ease of use not found with other compilers.

For easier source level debugging, the compiler provides symbol information that is compatible with the MPLAB IDE memory display.

9.14 <u>Fuzzy Logic Development System</u> (*fuzzy*TECH-MP)

*fuzzy*TECH-MP fuzzy logic development tool is available in two versions - a low cost introductory version, MP Explorer, for designers to gain a comprehensive working knowledge of fuzzy logic system design; and a full-featured version, *fuzzy*TECH-MP, Edition for implementing more complex systems.

Both versions include Microchip's *fuzzy*LAB[™] demonstration board for hands-on experience with fuzzy logic systems implementation.

9.15 <u>SEEVAL[®] Evaluation and</u> <u>Programming System</u>

The SEEVAL SEEPROM Designer's Kit supports all Microchip 2-wire and 3-wire Serial EEPROMs. The kit includes everything necessary to read, write, erase or program special features of any Microchip SEEPROM product including Smart Serials[™] and secure serials. The Total Endurance[™] Disk is included to aid in trade-off analysis and reliability calculations. The total kit can significantly reduce time-to-market and result in an optimized system.

9.16 <u>KEELOQ[®] Evaluation and</u> <u>Programming Tools</u>

KEELOQ evaluation and programming tools support Microchips HCS Secure Data Products. The HCS evaluation kit includes an LCD display to show changing codes, a decoder to decode transmissions, and a programming interface to program test transmitters.

TABLE 24CXX HCS200 25CXX HCS300 PIC17C4X PIC17C7XX PIC12C5XX PIC14000 PIC16C5X PIC16CXXX PIC16C6X PIC16C7XX PIC16C8X PIC16C9XX HCS301 93CXX 9-1: ulator Products MPLAB[™]-ICE ✓ ✓ ✓ \checkmark \checkmark ✓ √ ✓ ✓ ✓ **DEVELOPMENT TOOLS FROM MICROCHIP** ICEPIC[™] Low-Cost √ ✓ ✓ ✓ \checkmark \checkmark Εm In-Circuit Emulator **MPLAB**[™] Integrated ✓ ✓ ✓ ✓ \checkmark \checkmark \checkmark ✓ \checkmark \checkmark Development Environment Software Tools MPLAB™ C17* ✓ \checkmark Compiler fuzzyTECH[®]-MP Explorer/Edition ✓ ✓ ✓ ✓ ✓ √ ✓ √ ✓ Fuzzy Logic Dev. Tool Total Endurance™ ✓ Software Model **PICSTART[®]Plus** Low-Cost ✓ ✓ ✓ ✓ ✓ ✓ ✓ ✓ ✓ ✓ Universal Dev. Kit PRO MATE[®] II Universal ✓ ✓ ✓ ✓ ✓ ✓ ✓ ✓ ✓ ✓ ✓ \checkmark Programmer Pro **KEELOQ**[®] ✓ Programmer SEEVAL® ✓ **Designers Kit** SIMICE ✓ ✓ PICDEM-14A ✓ ds PICDEM-1 ✓ ✓ √ ✓ o Bo PICDEM-2 ✓ ✓ PICDEM-3 \checkmark ő KEELOQ® ✓ **Evaluation Kit** KEELOQ ✓ Transponder Kit

NOTES:

10.0 ELECTRICAL SPECIFICATIONS

Absolute Maximum Ratings †

Ambient Temperature under bias	–40° to +125°C
Storage Temperature	–65° to +150°C
Voltage on any pin with respect to Vss (except VDD and MCLR)	–0.6V to VDD +0.6V
Voltage on VDD with respect to Vss	0 to +7.5V
Voltage on MCLR with respect to Vss (Note 2)	0 to +14V
Total power Dissipation (Note 1)	1.0W
Maximum Current out of Vss pin	300 mA
Maximum Current into VDD pin	250 mA
Input Clamp Current, Iк (VI<0 or VI> VDD)	±20 mA
Output Clamp Current, Iок (V0 <0 or V0>VDD)	±20 mA
Maximum Output Current sunk by any I/O pin	25 mA
Maximum Output Current sourced by any I/O pin	25 mA
Maximum Current sunk by PORTA and PORTB	200 mA
Maximum Current sourced by PORTA and PORTB	200 mA
Note 1: Power dissipation is calculated as follows: $P_{DIS} = V_{DD} \times \{I_{DD} - \sum I_{OH}\} + \sum \{(V_{DD}-V_{OH})\}$	x IOH} + Σ (VOI x IOL)

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 10-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

osc	PIC16C55X-04	PIC16C55X-20	PIC16LC55X-04	PIC16C55X JW Devices
RC	VDD: 3.0V to 5.5V IDD: 3.3 mA max.@5.5V IPD: 20 μA max. @4.0V Freq: 4.0 MHz max.	VDD: 4.5V to 5.5V IDD: 1.8 mA typ. @5.5V IPD: 1.0 μA typ. @4.5V Freq: 4.0 MHz max.	VDD: 2.5V to 5.5V IDD: 1.4 mA typ. @3.0V IPD: 0.7 μA typ. @3.0V Freq: 4.0 MHz max.	VDD: 3.0V to 5.5V IDD: 3.3 mA max. @5.5V IPD: 20 μA max. @4.0V Freq: 4.0 MHz max.
ХТ	VDD: 3.0V to 5.5V IDD: 3.3 mA max.@5.5V IPD: 20 μA max. @4.0V Freq: 4.0 MHz max.	VDD: 4.5V to 5.5V IDD: 1.8 mA typ. @5.5V IPD: 1.0 µA typ. @4.5V Freq: 4.0 MHz max.	VDD: 2.5V to 5.5V IDD: 1.4 mA typ. @3.0V IPD: 0.7 μA typ. @3.0V Freq: 4.0 MHz max.	VDD: 3.0V to 5.5V IDD: 3.3 mA max. @5.5V IPD: 20 µA max. @4.0V Freq: 4.0 MHz max.
HS	VDD: 4.5V to 5.5V IDD: 9.0 mA typ. @5.5V IPD: 1.0 μA typ. @4.0V Freq: 4.0 MHz max.	VDD: 4.5V to 5.5V IDD: 20 mA max. @5.5V IPD: 1.0 μA typ. @4.5V Freq: 20 MHz max.	Do not use in HS mode	VDD: 4.5V to 5.5V IDD: 20 mA max.@5.5V IPD: 1.0 μA typ. @4.5V Freq: 20 MHz max.
LP	VDD: 3.0V to 5.5V IDD: 35 μA typ. @ 32 kHz, 3.0V IPD: 1.0 μA typ. @ 4.0 V Freq: 200 kHz maxi.	Do not use in LP mode	VDD: 2.5V to 5.5V IDD: 32 μA max. @32 kHz, 3.0V IPD: 9.0 μA max. @3.0V Freq: 200 kHz max.	VDD: 2.5V to 5.5V IDD: 32 μA max. @32 kHz, 3.0V IPD: 9.0 μA max. @3.0V Freq: 200 kHz max.

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.

10.1 DC CHARACTERISTICS:

PIC16C55X-04 (Commercial, Industrial, Extended) PIC16C55X-20 (Commercial, Industrial, Extended)

		Standard Operating Condition					
Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial and							
0° C \leq TA \leq +70°C for commercial and							
$-40^{\circ}C \le TA \le +125^{\circ}C$ for extended							-
Param No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
D001 D001A	Vdd	Supply Voltage	3.0 4.5	-	5.5 5.5	V V	XT, RC and LP osc configuration HS osc configuration
D002	Vdr	RAM Data Retention Voltage (Note 1)	-	1.5*	-	V	Device in SLEEP mode
D003	VPOR	VDD start voltage to ensure Power-on Reset	-	Vss	-	V	See section on power-on reset for details
D004	SVDD	VDD rise rate to ensure Power-on Reset	0.05*	-	-	V/ms	See section on power-on reset for details
D010	IDD	Supply Current (Note 2)	-	1.8	3.3	mA	XT and RC osc configuration Fosc = 4 MHz, VDD = 5.5V, WDT disabled (Note 4)
D010A			-	35	70	μA	LP osc configuration, PIC16C55X-04 only Fosc = 32 kHz, VDD = 4.0V, WDT disabled
D013			-	9.0	20	mA	HS osc configuration Fosc = 20 MHz, VDD = 5.5V, WDT disabled
D020	IPD	Power Down Current (Note 3)	-	1.0	2.5 15	μΑ μΑ	VDD=4.0V, WDT disabled (+85°C to +125°C)
	ΔIWDT	WDT Current (Note 5)	-	6.0	20	μΑ	VDD=4.0V (+85°C to +125°C)

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C, unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

 $OSC1 = external square wave, from rail to rail; all I/O pins configured as input, pulled to VDD, <math>\overline{MCLR} = VDD$; WDT enabled/disabled as specified.

3: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins configured as input and tied to VDD or Vss.

4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in k Ω .

5: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

10.2 DC CHARACTERISTICS: PIC16LC55X-04 (Commercial, Industrial, Extended)

		Standard Operating Condition	•				-
			$-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial and $0^{\circ}C \le TA \le +70^{\circ}C$ for commercial and $-40^{\circ}C \le TA \le +125^{\circ}C$ for extended				
Param No.	Sym	Characteristic	Min	Тур†		Units	Conditions
D001	Vdd	Supply Voltage	3.0 2.5	-	5.5 5.5	V	XT and RC osc configuration LP osc configuration
D002	Vdr	RAM Data Retention Voltage (Note 1)	-	1.5*	-	V	Device in SLEEP mode
D003	VPOR	VDD start voltage to ensure Power-on Reset	-	Vss	-	V	See section on Power-on Reset for details
D004	SVDD	VDD rise rate to ensure Power-on Reset	0.05*	_	-	V/ms	See section on Power-on Reset for details
D010	IDD	Supply Current (Note 2)	-	1.4	2.5	mA	XT and RC osc configuration Fosc = 2.0 MHz, VDD = 3.0V, WDT disabled (Note 4)
D010A			-	26	53	μA	LP osc configuration Fosc = 32 kHz, VDD = 3.0V, WDT disabled
D020	IPD	Power Down Current (Note 3)	-	0.7	2	μA	VDD=3.0V, WDT disabled
	Δ IWDT	WDT Current (Note 5)	-	6.0	15	μA	VDD=3.0V

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C, unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1=external square wave, from rail to rail; all I/O pins configured as input, pulled to VDD, $\overline{MCLR} = VDD$; WDT enabled/disabled as specified.

- 3: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins configured as input and tied to VDD or Vss.
- 4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kΩ.
- 5: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.
10.3 DC CHARACTERISTICS:

PIC16C55X (Commercial, Industrial, Extended) PIC16LC55X (Commercial, Industrial, Extended)

		Standard Operating Condition	ns (unle	ss otl	nerwise sta	ted)	
		Operating temperature -40°C	C ≤ TA ≤	+85°	C for industr	ial an	
		0°C			C for comme		
					°C for autom		
_	-	Operating voltage VDD range a					
Param. No.	Sym	Characteristic	Min	Тур†	Мах	Unit	Conditions
	Vi∟	Input Low Voltage					
		I/O ports					
D030		with TTL buffer	Vss	-	0.8V 0.15Vdd	V	VDD = 4.5V to 5.5V otherwise
D031		with Schmitt Trigger input	Vss		0.2Vdd	V	
D032		MCLR, RA4/T0CKI,OSC1 (in RC mode)	Vss	-	0.2Vdd	V	Note1
D033		OSC1 (in XT* and HS)	Vss	-	0.3Vdd	V	
		OSC1 (in LP*)	Vss	-	0.6Vdd-1.0	V	
	Vih	Input High Voltage					
		I/O ports		-			
D040		with TTL buffer	2.0V	-	Vdd	V	VDD = 4.5V to 5.5V
D041		with Schmitt Trigger input	0.25VDD + 0.8V		Vdd		otherwise
D042		MCLR RA4/T0CKI	0.8Vdd	-	Vdd	V	
D043		OSC1 (XT*, HS and LP*)	0.7Vdd	-	Vdd	V	
D043A		OSC1 (in RC mode)	0.9Vdd				Note1
D070	IPURB	PORTB weak pull-up current	50	200	400	μΑ	VDD = 5.0V, VPIN = VSS
	lı∟	Input Leakage Current					
	IIL	(Notes 2, 3) I/O ports (Except PORTA)			±1.0	Δ	Vss \leq VPIN \leq VDD, pin at hi-impedance
D060		PORTA	-	-	±0.5		$Vss \le VPIN \le VDD$, pin at hi-impedance
D061		RA4/T0CKI	-	-	±1.0		$Vss \le VPIN \le VDD$
D063		OSC1, MCLR	-	-	±5.0	μΑ	
							configuration
	Vol	Output Low Voltage					
D080		I/O ports	-	-	0.6	V	IOL=8.5 mA, VDD=4.5V, -40° to +85°C
			-	-	0.6	V	IOL=7.0 mA, VDD=4.5V, +125°C
D083		OSC2/CLKOUT	-	-	0.6	V	IOL=1.6 mA, VDD=4.5V, -40° to +85°C
		(RC only)	-	-	0.6	V	IOL=1.2 mA, VDD=4.5V, +125°C
	Vон	Output High Voltage (Note 3)					
D090		I/O ports (Except RA4)	VDD-0.7		-	V	IOH=-3.0 mA, VDD=4.5V, -40° to +85°C
			VDD-0.7	-	-	V	IOH=-2.5 mA,
Dago							VDD=4.5V, +125°C
D092		OSC2/CLKOUT	VDD-0.7		-		ІОН=-1.3 mA, VDD=4.5V, -40° to +85°С ІОН=-1.0 mA,
		(RC only)	VDD-0.7	-	-	V	IOH=-1.0 mA, VDD=4.5V, +125°C
*	Vod	Open-Drain High Voltage			10*	V	RA4 pin
*		e parameters are characterized	but not t	hated		v	10 (1 Pil)

These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1 pin is a Schmitt Trigger input. It is not recommended that the PIC16C55X be driven with external clock in RC mode.

2: The leakage current on the MCLR pin is strongly dependent on applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as coming out of the pin.

10.3 DC CHARACTERISTICS: PIC16C55X (Commercial, Industrial, Extended) PIC16LC55X (Commercial, Industrial, Extended) (Cont.)

	Standard Operating Condition	ons (unle	ss oth	nerwise sta	ated)				
	Derating temperature -40° C \leq TA \leq +85 $^{\circ}$ C for industrial and								
$0^{\circ}C \leq TA \leq +70^{\circ}C$ for commercial and									
-40° C \leq TA \leq +125 $^{\circ}$ C for automotive									
	Operating voltage VDD range	as descri	bed in	DC spec T	able 1	0-1			
Sym	Characteristic	Min	Тур†	Max	Unit	Conditions			
	Capacitive Loading Space								
	on Output Pins								
COSC2	OSC2 pin			15	pF	In XT, HS and LP modes when externa clock used to drive OSC1.			
Cio	All I/O pins/OSC2 (in RC mode)			50	pF				
	Sym Cosc2	Operating temperature -40°0 0°0 Operating voltage VDD range Sym Characteristic Capacitive Loading Specs on Output Pins OSC2 pin Cio All I/O pins/OSC2 (in RC	Operating temperature -40°C ≤ TA ≤ 0°C ≤ TA ≤ -40°C ≤ TA ≤ Operating voltage VDD range as descrive Sym Characteristic Min Capacitive Loading Specs on Output Pins Cosc2 OSC2 pin Cio All I/O pins/OSC2 (in RC	Operating temperature $-40^{\circ}C$ $\leq TA \leq +85^{\circ}C$ $0^{\circ}C$ $\leq TA \leq +70^{\circ}C$ $-40^{\circ}C$ $\leq TA \leq +725^{\circ}C$ Operating voltageVDD range as described inSymCharacteristicMinTyp†Capacitive Loading Specs on Output PinsCosc2OSC2 pinCioAll I/O pins/OSC2 (in RCI	Operating temperature $-40^{\circ}C$ $\leq TA \leq +85^{\circ}C$ for indust $0^{\circ}C$ $\leq TA \leq +70^{\circ}C$ for comm $-40^{\circ}C$ $\leq TA \leq +70^{\circ}C$ for autor $Operating voltageVDD range as described in DC spec TSymCharacteristicMinTyp†MaxCosc2OSC2 pin1515CioAll I/O pins/OSC2 (in RC50$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $			

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1 pin is a Schmitt Trigger input. It is not recommended that the PIC16C55X be driven with external clock in RC mode.

2: The leakage current on the MCLR pin is strongly dependent on applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as coming out of the pin.

10.4 <u>Timing Parameter Symbology</u>

The timing parameter symbols have been created with one of the following formats:

1. TppS2ppS

2. TppS

2. 1000				
Т				
F	Frequency	Т	Time	
Lowerc	ase subscripts (pp) and their meanings:			
рр				
ck	CLKOUT	os	OSC1	
io	I/O port	tO	TOCKI	
mc	MCLR			
Upperc	case letters and their meanings:			
S				
F	Fall	P	Period	
н	High	R	Rise	
1	Invalid (Hi-impedance)	V	Valid	
L	Low	Z	Hi-Impedance	

FIGURE 10-1: LOAD CONDITIONS



10.5 <u>Timing Diagrams and Specifications</u>





TABLE 10-2:	EXTERNAL CLOCK TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
	Fos	External CLKIN Frequency	DC	_	4	MHz	XT and RC osc mode, VDD=5.0V
		(Note 1)	DC	_	20	MHz	HS osc mode
			DC	_	200	kHz	LP osc mode
		Oscillator Frequency	DC	—	4	MHz	RC osc mode, VDD=5.0V
		(Note 1)	0.1	_	4	MHz	XT osc mode
			1	_	20	MHz	HS osc mode
			DC	-	200	kHz	LP osc mode
1	Tosc	External CLKIN Period	250	—	—	ns	XT and RC osc mode
		(Note 1)	50	—	—	ns	HS osc mode
			5	—	—	μs	LP osc mode
		Oscillator Period	250	—	—	ns	RC osc mode
		(Note 1)	250	—	10,000	ns	XT osc mode
			50	—	1,000	ns	HS osc mode
			5	—	—	μs	LP osc mode
2	TCY	Instruction Cycle Time (Note 1)	1.0	Fos/4	DC	μs	Tcy=Fos/4
3*	TosL,	External Clock in (OSC1) High or	100*	—	—	ns	XT osc mode
	TosH	Low Time	2*	_	_	μs	LP osc mode
			20*	_	_	ns	HS osc mode
4*	TosR,	External Clock in (OSC1) Rise or	25*	—	—	ns	XT osc mode
	TosF	Fall Time	50*	_	_	ns	LP osc mode
			15*	_	_	ns	HS osc mode

These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (TCY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1 pin.

When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.

FIGURE 10-3: CLKOUT AND I/O TIMING



Parameter #	Sym	Characteristic	Min	Тур†	Max	Units
10*	TosH2ckL	OSC1 [↑] to CLKOUT↓ (Note1)	_	75 —	200 400	ns ns
11*	TosH2ckH	OSC1 [↑] to CLKOUT [↑] (Note1)	_	75 —	200 400	ns ns
12*	TckR	CLKOUT rise time (Note1)		35 —	100 200	ns ns
13*	TckF	CLKOUT fall time (Note1)	_	35 —	100 200	ns ns
14*	TckL2ioV	CLKOUT ↓ to Port out valid (Note1)	_	—	20	ns
15*	TioV2ckH	Port in valid before CLKOUT ↑ (Note1)	Tosc +200 ns Tosc +400 ns	_	_	ns ns
16*	TckH2iol	Port in hold after CLKOUT ↑ (Note1)	0	—	_	ns
17*	TosH2ioV	OSC1 [↑] (Q1 cycle) to Port out valid	_	50	150 300	ns ns
18*	TosH2iol	OSC1 [↑] (Q2 cycle) to Port input invalid (I/O in hold time)	100 200	_	_	ns ns
19*	TioV2osH	Port input valid to OSC1 [↑] (I/O in setup time)	0	—	_	ns
20*	TioR	Port output rise time	_	10 —	40 80	ns ns
21*	TioF	Port output fall time	_	10 —	40 80	ns ns
22*	Tinp	RB0/INT pin high or low time	25 40	_	_	ns ns
23	Trbp	RB<7:4> change interrupt high or low time	Тсу		_	ns

TABLE 10-3:	CLKOUT AND I/O TIMING REQUIREMENTS

* These parameters are characterized but not tested

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc





RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP **TABLE 10-4:** TIMER REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
30	TmcL	MCLR Pulse Width (low)	2000	—	_	ns	-40° to +85°C
31	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7*	18	33*	ms	$VDD = 5.0V, -40^{\circ} \text{ to } +85^{\circ}C$
32	Tost	Oscillation Start-up Timer Period		1024 Tosc	_	_	Tosc = OSC1 period
33	Tpwrt	Power-up Timer Period	28*	72	132*	ms	$VDD = 5.0V, -40^{\circ} \text{ to } +85^{\circ}C$
34	Tioz	I/O hi-impedance from MCLR low		—	2.0	μs	

* These parameters are characterized but not tested. †

Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 10-5: TIMER0 CLOCK TIMING



TABLE 10-5: TIMER0 CLOCK REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Мах	Units	Conditions	
40	Tt0H	T0CKI High Pulse Width	No Prescaler	0.5 TCY + 20*	—	—	ns	
			With Prescaler	10*	_	—	ns	
41	Tt0L	T0CKI Low Pulse Width	No Prescaler	0.5 TCY + 20*	_	—	ns	
			With Prescaler	10*	_	—	ns	
42	Tt0P	T0CKI Period	•	<u>Tcy + 40</u> * N		_	ns	N = prescale value (1, 2, 4,, 256)

* These parameters are characterized but not tested.

Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 10-6: LOAD CONDITIONS



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11.0 PACKAGING INFORMATION

11.1 Package Marking Information

18-Lead PDIP



18-Lead SOIC (.300")



18-Lead CERDIP Windowed



20-Lead SSOP



Example

PIC16C558	
) — -04I / P456	
9823 CBA	١

Example



Example



Example



Legen	d: MMM	Microchip part number information
	XXX	Customer specific information*
	AA	Year code (last 2 digits of calendar year)
	BB	Week code (week of January 1 is week '01')
	С	Facility code of the plant at which wafer is manufactured
		O = Outside Vendor
		C = 5" Line
		S = 6" Line
		H = 8" Line
	D	Mask revision number
	Е	Assembly code of the plant or country of origin in which
		part was assembled
Note:	In the eve	nt the full Microchip part number cannot be marked on one line, it will
		l over to the next line thus limiting the number of available characters
		ner specific information.

Package Type: K04-010 18-Lead Ceramic Dual In-line with Window (JW) – 300 mil



Units			INCHES*		MILLIMETERS			
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX	
PCB Row Spacing			0.300			7.62		
Number of Pins	n		18			18		
Pitch	р	0.098	0.100	0.102	2.49	2.54	2.59	
Lower Lead Width	В	0.016	0.019	0.021	0.41	0.47	0.53	
Upper Lead Width	B1	0.050	0.055	0.060	1.27	1.40	1.52	
Shoulder Radius	R	0.010	0.013	0.015	0.25	0.32	0.38	
Lead Thickness	с	0.008	0.010	0.012	0.20	0.25	0.30	
Top to Seating Plane	A	0.175	0.183	0.190	4.45	4.64	4.83	
Top of Lead to Seating Plane	A1	0.091	0.111	0.131	2.31	2.82	3.33	
Base to Seating Plane	A2	0.015	0.023	0.030	0.00	0.57	0.76	
Tip to Seating Plane	L	0.125	0.138	0.150	3.18	3.49	3.81	
Package Length	D	0.880	0.900	0.920	22.35	22.86	23.37	
Package Width	E	0.285	0.298	0.310	7.24	7.56	7.87	
Radius to Radius Width	E1	0.255	0.270	0.285	6.48	6.86	7.24	
Overall Row Spacing	eB	0.345	0.385	0.425	8.76	9.78	10.80	
Window Width	W1	0.130	0.140	0.150	0.13	0.14	0.15	
Window Length	W2	0.190	0.200	0.210	0.19	0.2	0.21	

* Controlling Parameter.

JEDEC equivalent: MO-036 AE

Package Type: K04-007 18-Lead Plastic Dual In-line (P) – 300 mil



Units			INCHES*		Μ	ILLIMETERS	S
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
PCB Row Spacing			0.300			7.62	
Number of Pins	n		18			18	
Pitch	р		0.100			2.54	
Lower Lead Width	В	0.013	0.018	0.023	0.33	0.46	0.58
Upper Lead Width	B1 [†]	0.055	0.060	0.065	1.40	1.52	1.65
Shoulder Radius	R	0.000	0.005	0.010	0.00	0.13	0.25
Lead Thickness	С	0.005	0.010	0.015	0.13	0.25	0.38
Top to Seating Plane	A	0.110	0.155	0.155	2.79	3.94	3.94
Top of Lead to Seating Plane	A1	0.075	0.095	0.115	1.91	2.41	2.92
Base to Seating Plane	A2	0.000	0.020	0.020	0.00	0.51	0.51
Tip to Seating Plane	L	0.125	0.130	0.135	3.18	3.30	3.43
Package Length	D‡	0.890	0.895	0.900	22.61	22.73	22.86
Molded Package Width	E‡	0.245	0.255	0.265	6.22	6.48	6.73
Radius to Radius Width	E1	0.230	0.250	0.270	5.84	6.35	6.86
Overall Row Spacing	eB	0.310	0.349	0.387	7.87	8.85	9.83
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

* Controlling Parameter.

 Dimension "B1" does not include dam-bar protrusions. Dam-bar protrusions shall not exceed 0.003" (0.076 mm) per side or 0.006" (0.152 mm) more than dimension "B1."

Dimensions "D" and "E" do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.010" (0.254 mm) per side or 0.020" (0.508 mm) more than dimensions "D" or "E."

JEDEC equivalent: MS-001 AC

Package Type: K04-051 18-Lead Plastic Small Outline (SO) – Wide, 300 mil



Units			INCHES*		Μ	ILLIMETERS	S
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Pitch	р		0.050			1.27	
Number of Pins	n		18			18	
Overall Pack. Height	A	0.093	0.099	0.104	2.36	2.50	2.64
Shoulder Height	A1	0.048	0.058	0.068	1.22	1.47	1.73
Standoff	A2	0.004	0.008	0.011	0.10	0.19	0.28
Molded Package Length	D [‡]	0.450	0.456	0.462	11.43	11.58	11.73
Molded Package Width	E‡	0.292	0.296	0.299	7.42	7.51	7.59
Outside Dimension	E1	0.394	0.407	0.419	10.01	10.33	10.64
Chamfer Distance	X	0.010	0.020	0.029	0.25	0.50	0.74
Shoulder Radius	R1	0.005	0.005	0.010	0.13	0.13	0.25
Gull Wing Radius	R2	0.005	0.005	0.010	0.13	0.13	0.25
Foot Length	L	0.011	0.016	0.021	0.28	0.41	0.53
Foot Angle	φ	0	4	8	0	4	8
Radius Centerline	L1	0.010	0.015	0.020	0.25	0.38	0.51
Lead Thickness	С	0.009	0.011	0.012	0.23	0.27	0.30
Lower Lead Width	B [†]	0.014	0.017	0.019	0.36	0.42	0.48
Mold Draft Angle Top	α	0	12	15	0	12	15
Mold Draft Angle Bottom	β	0	12	15	0	12	15

* Controlling Parameter.

[†] Dimension "B" does not include dam-bar protrusions. Dam-bar protrusions shall not exceed 0.003" (0.076 mm) per side or 0.006" (0.152 mm) more than dimension "B."

[‡] Dimensions "D" and "E" do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.010" (0.254 mm) per side or 0.020" (0.508 mm) more than dimensions "D" or "E."

JEDEC equivalent: MS-013 AB



Package Type: K04-072 20-Lead Plastic Shrink Small Outine (SS) – 5.30 mm

Units			INCHES		М	ILLIMETERS	S*
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Pitch	р		0.026			0.65	
Number of Pins	n		20			20	
Overall Pack. Height	A	0.068	0.073	0.078	1.73	1.86	1.99
Shoulder Height	A1	0.026	0.036	0.046	0.66	0.91	1.17
Standoff	A2	0.002	0.005	0.008	0.05	0.13	0.21
Molded Package Length	D [‡]	0.278	0.283	0.289	7.07	7.20	7.33
Molded Package Width	E‡	0.205	0.208	0.212	5.20	5.29	5.38
Outside Dimension	E1	0.301	0.306	0.311	7.65	7.78	7.90
Shoulder Radius	R1	0.005	0.005	0.010	0.13	0.13	0.25
Gull Wing Radius	R2	0.005	0.005	0.010	0.13	0.13	0.25
Foot Length	L	0.015	0.020	0.025	0.38	0.51	0.64
Foot Angle	φ	0	4	8	0	4	8
Radius Centerline	L1	0.000	0.005	0.010	0.00	0.13	0.25
Lead Thickness	С	0.005	0.007	0.009	0.13	0.18	0.22
Lower Lead Width	B [†]	0.010	0.012	0.015	0.25	0.32	0.38
Mold Draft Angle Top	α	0	5	10	0	5	10
Mold Draft Angle Bottom	β	0	5	10	0	5	10

^{*} Controlling Parameter.

[†] Dimension "B" does not include dam-bar protrusions. Dam-bar protrusions shall not exceed 0.003" (0.076 mm) per side or 0.006" (0.152 mm) more than dimension "B."

 Dimensions "D" and "E" do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.010" (0.254 mm) per side or 0.020" (0.508 mm) more than dimensions "D" or "E."
 JEDEC equivalent: MO-150 AE

APPENDIX A: ENHANCEMENTS

The following are the list of enhancements over the PIC16C5X microcontroller family:

- Instruction word length is increased to 14 bits. This allows larger page sizes both in program memory (4K now as opposed to 512 before) and register file (up to 128 bytes now versus 32 bytes before).
- 2. A PC high latch register (PCLATH) is added to handle program memory paging. PA2, PA1, PA0 bits are removed from STATUS register.
- 3. Data memory paging is slightly redefined. STATUS register is modified.
- Four new instructions have been added: RETURN, RETFIE, ADDLW, and SUBLW.
 Two instructions TRIS and OPTION are being phased out although they are kept for compatibility with PIC16C5X.
- 5. OPTION and TRIS registers are made addressable.
- 6. Interrupt capability is added. Interrupt vector is at 0004h.
- 7. Stack size is increased to 8 deep.
- 8. Reset vector is changed to 0000h.
- Reset of all registers is revised. Three different reset (and wake-up) types are recognized. Registers are reset differently.
- 10. Wake up from SLEEP through interrupt is added.
- 11. Two separate timers, Oscillator Start-up Timer (OST) and Power-up Timer (PWRT) are included for more reliable power-up. These timers are invoked selectively to avoid unnecessary delays on power-up and wake-up.
- 12. PORTB has weak pull-ups and interrupt on change feature.
- 13. Timer0 clock input, T0CKI pin is also a port pin (RA4/T0CKI) and has a TRIS bit.
- 14. FSR is made a full 8-bit register.
- 15. "In-circuit programming" is made possible. The user can program PIC16C55X devices using only five pins: VDD, VSS, VPP, RB6 (clock) and RB7 (data in/out).
- 16. PCON status register is added with a Power-on-Reset (POR) status bit.
- 17. Code protection scheme is enhanced such that portions of the program memory can be protected, while the remainder is unprotected.
- 18. PORTA inputs are now Schmitt Trigger inputs.

APPENDIX B: COMPATIBILITY

To convert code written for PIC16C5X to PIC16C55X, the user should take the following steps:

- 1. Remove any program memory page select operations (PA2, PA1, PA0 bits) for CALL, GOTO.
- 2. Revisit any computed jump operations (write to PC or add to PC, etc.) to make sure page bits are set properly under the new scheme.
- 3. Eliminate any data memory page switching. Redefine data variables to reallocate them.
- 4. Verify all writes to STATUS, OPTION, and FSR registers since these have changed.
- 5. Change reset vector to 0000h.

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